



**TPS2388** SLUSC25A - FEBRUARY 2015-REVISED AUGUST 2017

# TPS2388 IEEE 802.3at 8-Channel Power-over-Ethernet PSE Controller

#### **Features**

- Fully IEEE 802.3at Compliant
- Port Re-Mapping
- 1- and 3-Bit Fast Port Shutdown Input
- "Never Fooled" 4-Point Detection
- Type 1 and Type 2 PD Classification
- Programmable Current Limit With Foldback
- DC Disconnect Detection
- Flexible Processor Controlled Operating Modes
  - Semiauto
  - Manual
- 14-Bit Port Current and Voltage Monitoring
  - 100-ms Rolling Port Current Averaging
  - 2% Current Sensing Accuracy
  - 0.255-Ω Sense Resistor With Kelvin Sense
- I<sup>2</sup>C Communication
  - I<sup>2</sup>C Watchdog for Failsafe Operation
  - 8- and 16-Bit Access Mode Selectable
- -40°C to 125°C Temperature Operation
- 56-Lead VQFN Package

# **Applications**

- **Enterprise Switches and Routers**
- SoHo Switches and Routers
- PoE Pass-Through Power Modules
- Network Video Recorders (NVRs)

### 3 Description

TPS2388 is an 8-channel power source equipment (PSE) controller engineered to insert power onto Ethernet cable according to IEEE 802.3at-2012 standard (or 802.3at). The PSE controller can detect powered devices (PDs) that have a valid signature, determine the power requirements according to the classification, and apply power through either one (Type -1) or twoevent (Type-2) physical classification. The TPS2388 also has the flexibility to support UPoE and other non-standard loads.

The Port remapping and the device pinout allow designers to enable 2-layer PCB designs and simplify software migration from previous generation PSE devices. The external FET architecture allows designers to further balance size, efficiency, thermal, and solution cost requirements. The current foldback reduces thermal stress on the external MOSFETs during startup and overload conditions allowing the use of cheaper FETs.

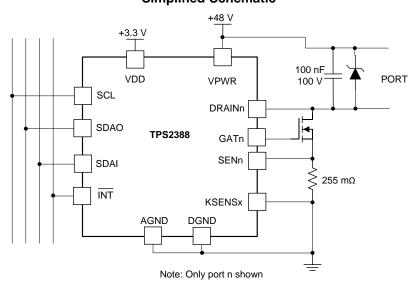
The Fast Shutdown (OSS) input provides up to eight levels of per port shutdown priority for applications that require the immediate disabling of multiple ports.

### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
TPS2388	VQFN (56)	8.00 mm × 8.00 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

# Simplified Schematic





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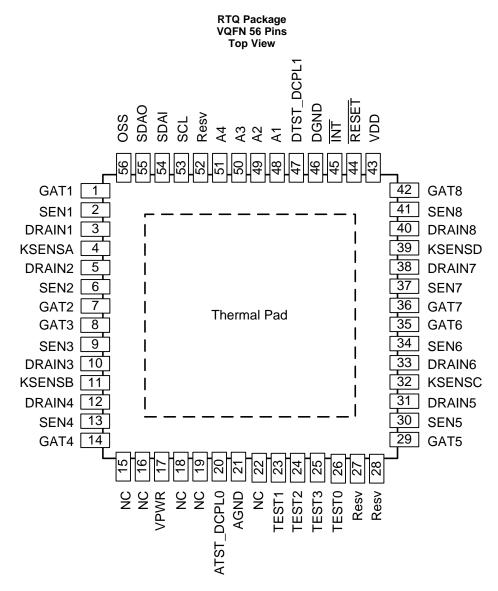
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# 4 Revision History

DATE	REVISION	NOTES
August 2017	*	1st public release of data sheet.



# 5 Pin Configuration and Functions



Pin Functions

	PIN Functions					
ı	PIN	1/0	DESCRIPTION			
NAME	NO.	1/0	DESCRIF HON			
A1-4	48–51	- 1	I <sup>2</sup> C A1-A4 address lines. These pins are internally pulled up to VDD.			
AGND	21	_	Analog ground. Connect to GND plane and exposed thermal pad.			
ATST_DCPL0	20	0	Used for internal test purposes, no bypass capacitor is needed.			
DGND	46	_	Digital ground. Connect to GND plane and exposed thermal pad.			
DRAIN1-8	3, 5, 10, 12, 31, 33, 38, 40	I	Port 1-8 output voltage monitor.			
DTST_DCPL1	47	0	Used for internal test purposes, no bypass capacitor is needed.			
GAT1-8	1, 7, 8, 14, 29, 35, 36, 42	0	Port 1-8 gate drive output.			
ĪNT	45	0	Interrupt output. This pin asserts low when a bit in the interrupt register is asserted. This output is open-drain.			
KSENSA/B	4, 11	I	Kelvin point connection for SEN1-4			
KSENSC/D	32, 39	I	Kelvin point connection for SEN5-8			



#### Pin Functions (continued)

P	IN		
NAME	NO.	1/0	DESCRIPTION
NC	15, 16, 18, 19	0	No connect pins. These pins are internally biased at 1/3 and 2/3 of VPWR in order to control the voltage gradient from VPWR. Leave open.
	22	_	No connect pin. Leave open.
OSS	56	- 1	Port 1-8 fast shutdown. This pin is internally pulled down to DGND.
Thermal pad	_	_	The DGND and AGND terminals must be connected to the exposed thermal pad for proper operation.
RESET	44	- 1	Reset input. When asserted low, the TPS2388 is reset. This pin is internally pulled up to VDD.
Resv	27, 28, 52	_	Reserved. No connect pins. Leave open.
SCL	53	I	Serial clock input for I <sup>2</sup> C bus.
SDAI	54	I	Serial data input for I <sup>2</sup> C bus. This pin can be connected to SDAO for non-isolated systems.
SDAO	55	0	Serial data output for I <sup>2</sup> C bus. This pin can be connected to SDAI for non-isolated systems. This output is open-drain.
SEN1-8	2, 6, 9, 13, 30, 34, 37, 41	ı	Port 1-8 current sense input.
TEST0-3	23, 24, 25, 26	I/O	Used internally for test purposes only. Leave open.
VDD	43	_	Digital supply. Bypass with 0.1 μF to DGND pin.
VPWR	17	_	Analog 48-V positive supply. Bypass with 0.1 μF to AGND pin.

### 5.1 Detailed Pin Description

The following descriptions refer to the pinout and the functional block diagram.

**DRAIN1-DRAIN8:** Port 1-8 output voltage monitor and detect sense. Used to measure the port output voltage, for port voltage monitoring, port power good detection and foldback action. Detection probe currents also flow into this pin.

The TPS2388 uses an innovative 4-point technique to provide reliable PD detection. The discovery is performed by sinking two different current levels via the DRAINn pin, while the PD voltage is measured from VPWR to DRAINn. The 4-point measurement provides the capability to avoid powering a capacitive or legacy load. Also, while in semiauto mode, if prior to starting a new detection cycle the port voltage is >2.5 V, an internal  $100-k\Omega$  resistor is connected in parallel with the port and a 400-ms detect backoff period is applied to allow the port capacitor to be discharged before the detection cycle starts.

There is an internal resistor between each DRAINn pin and VPWR in any operating mode except during detection or while the port is ON. If the port n is not used, DRAINn can be left floating or tied to AGND.

**GAT1-GAT8:** Port 1-8 gate drive output is used for external N-channel MOSFET gate control. At port turn on, it is driven positive by a low current source to turn the MOSFET on. GATn is pulled low whenever any of the input supplies are low or if an overcurrent timeout has occurred. GATn is also pulled low if its port is turned off by use of manual shutdown inputs. Leave floating if unused.

For a robust design, a current foldback function limits the power dissipation of the MOSFET during low resistance load or a short-circuit event. During inrush, the foldback mechanism measures the port voltage across VPWR and DRAINn to reduce the current limit threshold as shown in Figure 17.

When  $I_{CUT}$  threshold is exceeded while a port is on, a timer starts. During that time, linear current limiting ensures the current does not exceed  $I_{LIM}$  combined with current foldback action. When the timer reaches its  $t_{OVLD}$  (or  $t_{START}$  if at port turn on) limit, the part shuts off. When the port current goes below  $I_{CUT}$ , the counter counts down at a rate  $1/16^{th}$  of the increment rate and it must reach a count of 0 before the port can be turned on again.

The fast overload protection is for major faults like a direct short. This forces the MOSFET into current limit in less than a microsecond.

The circuit leakage paths between the GATn pin and any nearby DRAINn pin, GND or Kelvin point connection must be minimized (<250 nA), to ensure correct MOSFET control.

**INT**: This interrupt output pin asserts low when a bit in the interrupt register is asserted. This output is open-drain.

**KSENSA**, **KSENSB**, **KSENSC**, **KSENSD**: Kelvin point connection used to perform a differential voltage measurement across the associated current sense resistors.

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### **Detailed Pin Description (continued)**

Each KSENS is shared between two neighbor SEN pins as following: KSENSA with SEN1 and SEN2, KSENSB with SEN3 and SEN4, KSENSC with SEN5 and SEN6, KSENSD with SEN7 and SEN8. To optimize the accuracy of the measurement, take care with the PCB layout to minimize the impact of the PCB traces' resistance.

**OSS:** Fast shutdown, active high. This pin is internally pulled down to DGND, with an internal 1-µs to 5-µs deglitch filter.

The Port Power Priority/ICUT Disable register is used to determine which port is shut down in response to an external assertion of the OSS fast shutdown signal. The turn off procedure is similar to a port reset using Reset command (1Ah register).

**RESET:** Reset input, active low. When asserted, the TPS2388 resets, turning off all ports and forcing the registers to their power-up state. This pin is internally pulled up to VDD, with internal 1-µs to 5-µs deglitch filter. The designer can use an external RC network to delay the turn-on. There is also an internal power-on-reset which is independent of the RESET input.

#### **NOTE**

During the first 5 ms after RESET has been asserted, if a port is turned on using the Power Enable command (0x19), TI recommends to wait for the expiration of that 5-ms initial period before sending any subsequent Detect/Class Restart or Detect/Class Enable command.

**SCL:** Serial clock input for I<sup>2</sup>C bus.

**SDAI:** Serial data input for I<sup>2</sup>C bus. This pin can be connected to SDAO for non-isolated systems.

**SDAO:** Open-drain I<sup>2</sup>C bus output data line. Requires an external resistive pull-up. The TPS2388 uses separate SDAO and SDAI lines to allow optoisolated I<sup>2</sup>C interface. SDAO can be connected to SDAI for non-isolated systems.

**A4-A1:** I<sup>2</sup>C bus address inputs. These pins are internally pulled up to VDD. See *Pin Status Register* for more details.

**SEN1-8:** Port current sense input relative to KSENSn (see KSENSn description). A differential measurement is performed using KSENSA-D Kelvin point connection. Monitors the external MOSFET current by use of a  $0.255-\Omega$  current sense resistor connected to DGND. Used by current foldback engine and also during classification. Can be used to perform load current monitoring via A/D conversion.

Note that a classification is done while using the external MOSFET so that doing a classification on more than one port at same time is possible without overdissipation in the TPS2388. For the current limit with foldback function, there is an internal 2-µS analog filter on the SEN1-8 pins to provide glitch filtering. For measurements through an A/D converter, an anti-aliasing filter is present on the SEN1-8 pins. This includes the port-powered current monitoring, port policing, and DC disconnect.

If the port is not used, tie SENn to AGND.

**VDD:** 3.3-V logic power supply input.

**VPWR:** High voltage power supply input. Nominally 48 V.



### 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)

		MIN	MAX	UNIT
VPWR   VDD	VPWR	-0.3	70	V
	VDD	-0.3	4	V
input voitage	OSS, RESET, A1-A4	-0.3	4	V
Output voltage  Voltage  Voltage  Sink current  Lead temperature 1.	SEN1-8, (2) KSENSA, KSENSB, KSENSC, KSENSD	-0.3	3	V
Output voltage	GATE1-8 <sup>(3) (4)</sup>	-0.3	12	V
Voltage	SDAI, SDAO <sup>(5)</sup> , SCL, <del>INT</del>	-0.3	4	V
	DRAIN1-8 (5) (6)	-0.3	70	V
voltage	VR -0.3 70  5, RESET, A1-A4  -0.3 4  I1-8, (2) KSENSA, KSENSB, KSENSC, KSENSD  -0.3 12  II, SDAO (5), SCL, INT  -0.3 4  INN1-8 (5) (6)  -0.3 70  ITO-3, ATST_DCPL0, DTST_DCPL1 (5)  -0.3 0.3  SDAO  m (1/16-inch) from case for 10 seconds	V		
	AGND	-0.3	0.3	V
Sink current	ĪNT, SDAO		20	mA
Lead temperature	1.6 mm (1/16-inch) from case for 10 seconds		260	°C
T <sub>stg</sub>	Storage temperature	-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- (2) SEN1-8 are tolerant to 15-V transients to avoid fault propagation when a MOSFET fails in short-circuit
- (3) Application of voltage is not implied; these are internally driven pins.
- (4) If the external MOSFET fails short between its drain and gate, the GATE pin may internally permanently disconnect to prevent cascade damage. The three other ports continue to operate.
- (5) Do not apply external voltage sources directly
- (6) Short transients (µs range) up to 80 V are allowed

### 6.2 ESD Ratings

			VALUE	UNIT
, Electrostatic	Electrostatic	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	±2000	\ /
V <sub>(ESD)</sub>	discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	±500	٧

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
$V_{VDD}$		3	3.3	3.6	V
$V_{VPWR}$		44	48	57	V
	Voltage slew rate on VPWR			1	V/µs
TJ	Operating junction temperature	-40		125	°C
T <sub>A</sub>	Operating free-air temperature	-40		85	°C

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#### 6.4 Thermal Information

	THERMAL METRIC <sup>(1)</sup>	TPS2388	LIAUT
	THERMAL METRIC"	VQFN (56 PINS)	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	25.3	
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	9.7	
$R_{\theta JB}$	Junction-to-board thermal resistance	3.7	°C/\/
ΨЈТ	Junction-to-top characterization parameter	0.2	°C/W
ΨЈВ	Junction-to-board characterization parameter	3.7	
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	0.5	

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

#### 6.5 Electrical Characteristics

 $-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le 125^{\circ}\text{C}$  unless otherwise noted.  $\text{V}_{\text{VDD}} = 3.3 \text{ V}$ ,  $\text{V}_{\text{PWR}} = 48 \text{ V}$ ,  $\text{V}_{\text{DGND}} = \text{V}_{\text{AGND}}$ , DGND, KSENSA, KSENSB, KSENSC, and KSENSD connected to AGND, and all outputs are unloaded, unless otherwise noted. PoEPn = 0. Positive currents are into pins.  $\text{R}_{\text{S}} = 0.255~\Omega$ , to KSENSA (SEN1 or SEN2), to KSENSB (SEN3 or SEN4), to KSENSC (SEN5 or SEN6) or to KSENSD (SEN7 or SEN8). Typical values are at 25°C. All voltages are with respect to AGND, unless otherwise noted. Operating registers loaded with default values, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
INPUT SUP	PLY VPWR				1	
	VDWD current concurration	V <sub>VPWR</sub> = 50 V		10	12.5	mA
I <sub>VPWR</sub>	VPWR current consumption	V <sub>VPWR</sub> < 8 V			100	μA
V <sub>UVLOPW_F</sub>	VPWR UVLO falling threshold		14.5		17.5	V
V <sub>UVLOPW_R</sub>	VPWR UVLO rising threshold		15.5		18.5	V
V <sub>PUV_F</sub>	VPWR undervoltage falling threshold	VPUV threshold	25	26.5	28	V
TOTAL DEV	ICE POWER DISSIPATION					
P <sub>T</sub>	VPWR and VDD consumption	V <sub>VPWR</sub> = 50 V			0.67	W
INPUT SUP	PLY VDD					
I <sub>VDD</sub>	VDD Current consumption			6	12	mA
$V_{UVDD\_F}$	VDD UVLO falling threshold	For port deassertion	2.1	2.25	2.4	V
$V_{UVDD_R}$	VDD UVLO rising threshold		2.45	2.6	2.75	V
V <sub>UVDD_HYS</sub>	Hysteresis VDD UVLO			0.35		V
V <sub>UVW_F</sub>	VDD UVLO warning threshold		2.6	2.8	3.0	V
DETECTION	I					
		First detection point, V <sub>VPWR</sub> – V <sub>DRAINn</sub> = 0 V	145	160	190	
I <sub>DISC</sub>	Detection current	Second detection point, V <sub>VPWR</sub> - V <sub>DRAINn</sub> = 0	235	270	300	μΑ
		High-current detection point, V <sub>VPWR</sub> – V <sub>DRAINn</sub> = 0 V	490	540	585	
V <sub>detect</sub>	Open-circuit detection voltage	$V_{VPWR} - V_{DRAINn}$	23.5	26	29	V
R <sub>REJ_LOW</sub>	Rejected resistance low range		0.86		15	kΩ
R <sub>REJ_HI</sub>	Rejected resistance high range		33		100	kΩ
R <sub>ACCEPT</sub>	Accepted resistance range		19	25	26.5	kΩ
R <sub>SHORT</sub>	Shorted port threshold				360	Ω
R <sub>OPEN</sub>	Open port threshold		400			kΩ



### **Electrical Characteristics (continued)**

 $-40^{\circ}\text{C} \leq \text{T}_{\text{J}} \leq 125^{\circ}\text{C}$  unless otherwise noted.  $\text{V}_{\text{VDD}} = 3.3 \text{ V}$ ,  $\text{V}_{\text{VPWR}} = 48 \text{ V}$ ,  $\text{V}_{\text{DGND}} = \text{V}_{\text{AGND}}$ , DGND, KSENSA, KSENSB, KSENSC, and KSENSD connected to AGND, and all outputs are unloaded, unless otherwise noted. PoEPn = 0. Positive currents are into pins.  $\text{R}_{\text{S}} = 0.255~\Omega$ , to KSENSA (SEN1 or SEN2), to KSENSB (SEN3 or SEN4), to KSENSC (SEN5 or SEN6) or to KSENSD (SEN7 or SEN8). Typical values are at 25°C. All voltages are with respect to AGND, unless otherwise noted. Operating registers loaded with default values, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
CLASSIFIC						J.111
02/100//10		V <sub>VPWR</sub> - V <sub>DRAINn</sub> , V <sub>SENn</sub> ≥ 0 mV,				
V <sub>CLASS</sub>	Classification voltage	$I_{port} \ge 180 \mu\text{A}$	15.5	18.5	20.5	V
I <sub>CLASS_Lim</sub>	Classification current limit	VVPWR – VDRAINn = 0 V	65	75	90	mA
		Class 0-1	5		8	mA
		Class 1-2	13		16	mA
$I_{CLASS\_TH}$	Classification threshold current	Class 2-3	21		25	mA
		Class 3-4	31		35	mA
		Class 4-Class overcurrent	45		51	mA
$V_{MARK}$	Mark voltage	4 mA ≥ Iport ≥ 180 μA, VVPWR – VDRAINn	7		10	V
I <sub>MARK_Lim</sub>	Mark sinking current limit	$V_{VPWR} - V_{DRAINn} = 0 V$	10	70	90	mA
GATE						
$V_{GOH}$	Gate drive voltage	V <sub>GATEn</sub> , I <sub>GATE</sub> = -1 μA	10		12.5	V
I <sub>GO</sub> .	Gate sinking current with Power-on Reset, OSS detected or port turn off command	V <sub>GATEn</sub> = 5 V	60	100	190	mA
I <sub>GO short-</sub>	Gate sinking current with port short-circuit	$V_{GATEn} = 5 \text{ V}, V_{SENn} \ge V_{short} \text{ (or Vshort2X if 2X mode)}$	60	100	190	mA
I <sub>GO+</sub>	Gate sourcing current	V <sub>GATEn</sub> = 0V	39	50	63	μΑ
DRAIN INP	JT					ı
$V_{PGT}$	Power Good threshold	Measured at V <sub>DRAINn</sub>	1.0	2.13	3	V
V <sub>SHT</sub>	Shorted FET threshold	Measured at V <sub>DRAINn</sub>	4	6	8	V
R <sub>DRAIN</sub>	Resistance from DRAINn to VPWR	Any operating mode except during detection or while the port is ON, including in device RESET state	80	100	190	kΩ
I <sub>DRAIN</sub>	DRAINn pin bias current	V <sub>VPWR</sub> – V <sub>DRAINn</sub> = 30 V, port ON		75	120	μΑ
A/D CONVE	RTER					
t <sub>CONV</sub>	Conversion time, current measurement	All ranges, each port	0.64	0.8	0.96	ms
t <sub>CONV_V</sub>	Conversion time, voltage measurement	All ranges, each port	0.82	1.03	1.2	ms
	Gap between adjacent current measurement integrations				5% × t <sub>CONV</sub>	ms
t <sub>GAP</sub>	Gap between adjacent current averaged results				5% × t <sub>INT_CUR</sub>	ms
ADC <sub>BW</sub>	ADC integration bandwidth (-3 db)	Current measurement		320		Hz
t <sub>INT_CUR</sub>	Integration (averaging) time, current	Each port, port ON current	82	102	122	ms
t <sub>INT DET</sub>	Integration (averaging) time, detection		13.1	16.6	20	ms
t <sub>INT_portV</sub>	Integration (averaging) time, port voltage	Port powered	3.25	4.12	4.9	ms
t <sub>INT_inV</sub>	Integration (averaging) time, input voltage		3.25	4.12	4.9	ms
<del></del>	Powered port voltage conversion scale factor and	At V <sub>VPWR</sub> – V <sub>DRAINn</sub> = 57 V	15097	15565	16032	Counts
	accuracy	At V <sub>VPWR</sub> – V <sub>DRAINn</sub> = 44 V	11654	12015	12375	Counts
	Powered port current conversion scale factor and	At port current = 770 mA	12363	12616	12868	Counts
	accuracy	At port current = 7.5 mA	100	123	150	
		At V <sub>VPWR</sub> = 57 V	15175	15565	15955	Counts
	Input voltage conversion scale factor and accuracy	At V <sub>VPWR</sub> = 44 V	11713	12015	12316	Counts
$\delta_V/V_{port}$	Voltage reading accuracy	At 44 to 57 V	-3%		3%	
σ <sub>V</sub>	Voltage reading repeatability	Full scale reading	-18		18	mV
٧	2 2	At 50 mA	-3%		3%	
$\delta_I/I_{port}$	Current reading accuracy	At 770 mA	-2%		2%	
$\sigma_{l}$	Current reading repeatability	Full scale reading	-7.5		7.5	mA

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### **Electrical Characteristics (continued)**

 $-40^{\circ}\text{C} \leq \text{T}_{\text{J}} \leq 125^{\circ}\text{C}$  unless otherwise noted.  $\text{V}_{\text{VDD}} = 3.3 \text{ V}$ ,  $\text{V}_{\text{VPWR}} = 48 \text{ V}$ ,  $\text{V}_{\text{DGND}} = \text{V}_{\text{AGND}}$ , DGND, KSENSA, KSENSB, KSENSC, and KSENSD connected to AGND, and all outputs are unloaded, unless otherwise noted. PoEPn = 0. Positive currents are into pins.  $\text{R}_{\text{S}} = 0.255~\Omega$ , to KSENSA (SEN1 or SEN2), to KSENSB (SEN3 or SEN4), to KSENSC (SEN5 or SEN6) or to KSENSD (SEN7 or SEN8). Typical values are at 25°C. All voltages are with respect to AGND, unless otherwise noted. Operating registers loaded with default values, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$\delta_R/R_{port}$	Resistance reading accuracy	15 kΩ ≤ $R_{port}$ ≤ 33 kΩ, $C_{port}$ ≤ 0.25 μF, at 44 to 57 V	-7%		7%	
PORT CUR	RRENT SENSE		•			
		V <sub>DRAINn</sub> = 0 V, POL(3:0) = 0001b	9.6	10.2	10.8	
		V <sub>DRAINn</sub> = 0 V, POL(3:0) = 0010b	14.53	15.3	16.06	mV
		V <sub>DRAINn</sub> = 0 V, POL(3:0) = 0111b	38.76	40.8	42.84	
PORT CURRE  VCUT  Sov/Vpolice  Volintush  VLIM2X  Vshort  Vshort2X  bias  VIMIN  DIGITAL INTE  VIH  VIL	I <sub>CUT</sub> limit	V <sub>DRAINn</sub> = 0 V, POL(3:0) = 1111b	77.5	81.6	85.6	
		V <sub>DRAINn</sub> = 0 V, POL(3:0) = 0000b, PoEPn = 1	77.5	81.6	85.6	
		V <sub>DRAINn</sub> = 0 V, POL(3:0) = 1111b, PoEPn = 1	222.8	234.6	246.3	
$\delta_V/V_{police}$	Police setting resolution		-6.3%		6.3%	
$\delta_{\text{icut}}/I_{\text{CUT}}$	I <sub>CUT</sub> tolerance	All settings except POL(3:0) = 0000b and 0001b while PoEPn = 0	-5%		5%	
		V <sub>VPWR</sub> - V <sub>DRAINn</sub> = 1 V	10	23	31	
.,		V <sub>VPWR</sub> - V <sub>DRAINn</sub> = 10 V	20	33	46	
V <sub>Inrush</sub>	I <sub>Inrush</sub> limit, 1x or 2x mode	V <sub>VPWR</sub> - V <sub>DRAINn</sub> = 30 V	102		114.7	mV
		V <sub>VPWR</sub> - V <sub>DRAINn</sub> = 55 V	102		114.7	
		V <sub>DRAINn</sub> = 1 V	102		114.7	
V <sub>LIM</sub>	I Para	V <sub>DRAINn</sub> = 13 V	102		114.7	mV
	I <sub>LIM</sub> limit in 1x mode	V <sub>DRAINn</sub> = 30 V	15	23	31	
		V <sub>DRAINn</sub> = 48 V	15	23	31	
		V <sub>DRAINn</sub> = 1 V	260	270.3	285	mV
.,		V <sub>DRAINn</sub> = 10 V	127	140	153	
V <sub>LIM2X</sub>	I <sub>LIM</sub> limit in 2X mode (PoEPn = 1)	V <sub>DRAINn</sub> = 30 V	15	23	31	
V <sub>LIM2X</sub> I <sub>L</sub>		V <sub>DRAINn</sub> = 48 V	15	23	31	
V <sub>short</sub>	I <sub>short</sub> threshold in 1X mode and during inrush	Threshold for GATE to be less than 1 V,	234		306	.,
V <sub>short2X</sub>	I <sub>short</sub> threshold in 2X mode	2 μS after application of pulse	357		408	mV
I <sub>bias</sub>	Sense pin bias current	Port ON or during class	-2.5		0	μA
V <sub>IMIN</sub>	DC disconnect threshold		1.275		2.55	mV
DIGITAL IN	NTERFACE AT V <sub>VDD</sub> = 3.3 V					
V <sub>IH</sub>	Digital input high		2.1			V
V <sub>IL</sub>	Digital input low				0.9	V
V <sub>IT_HYS</sub>	Input voltage hysteresis (SCL, SDAI, A1-A4, RESET, OSS)		0.17			V
V	Digital output Low, SDAO	At 9 mA			0.4	V
V <sub>OL</sub>	Digital output Low, INT	At 3 mA			0.4	V
R <sub>pullup</sub>	Pullup resistor to VDD	RESET, A1-A4, TEST0	30	50	80	kΩ
_	Bulldown register to DCND	OSS	30	50	80	kO
R <sub>pulldown</sub>	Pulldown resistor to DGND	TEST1, 2	30	50	80	kΩ
THERMAL	SHUTDOWN					
т	Shutdown temperature	Temperature rising	135	146		°C
$T_{SD}$	Hysteresis			7		°C



### 6.6 Timing Requirements

			MIN	TYP	MAX	UNIT
f <sub>SCL</sub>	SCL clock frequency		10		400	kHz
$t_{LOW}$	LOW period of the clock		1.3			μs
t <sub>HIGH</sub>	HIGH period of the clock		0.6			μs
+.	SDAO output fall time	SDAO, $2.3 \rightarrow 0.8$ V, Cb = 10 pF, 10 k $\Omega$ pull-up to 3.3 V	21		250	ns
t <sub>fo</sub>	SDAO output fail time	SDAO, $2.3 \rightarrow 0.8$ V, Cb = 400 pF, 1.3 k $\Omega$ pull-up to 3.3 V	21		250	ns
C <sub>I2C</sub>	SCL capacitance				10	pF
C <sub>I2C_SDA</sub>	SDAI, SDAO capacitance (each)				6	pF
t <sub>SU,DATW</sub>	Data set-up time (Write operation)		100			ns
t <sub>SU,DATR</sub>	Data set-up time (Read operation)	SDAO, Cb = 10 pF, 1.3 k $\Omega$ pull-up to 3.3V	600			ns
t <sub>HD,DATW</sub>	Data hold time (Write operation)		0			ns
t <sub>HD,DATR</sub>	Data hold time (Read operation)		150		600	ns
$t_{fSDA}$	Input fall times of SDAI	$2.3 \rightarrow 0.8 \text{ V}$	20		250	ns
$t_{rSDA}$	Input rise times of SDAI	$0.8 \rightarrow 2.3 \text{ V}$	20		300	ns
t <sub>r</sub>	Input rise time of SCL	$0.8 \rightarrow 2.3 \text{ V}$	20		300	ns
t <sub>f</sub>	Input fall time of SCL	$2.3 \rightarrow 0.8 \text{ V}$	20		200	ns
t <sub>BUF</sub>	Bus free time between a STOP and STAR	T condition	1.3			μs
t <sub>HD,STA</sub>	Hold time after (repeated) Start condition		0.6			μs
t <sub>SU,STA</sub>	Repeated Start condition set-up time		0.6			μs
t <sub>SU,STO</sub>	Stop condition set-up time		0.6			μs
t <sub>FLT_INT</sub>	Fault to INT assertion	Time to internally register an Interrupt fault, from port turn off		50	500	μs
$t_{DG}$	Suppressed spike pulse width, SDAI and S	SCL	50			ns
t <sub>RDG</sub>	RESET input minimum pulse width (deglito	ch time)			5	μs
t <sub>bit_OSS</sub>	3-bit OSS bit period	MbitPrty = 1	24	25	26	μs
t <sub>OSS_IDL</sub>	Idle time between consecutive shutdown code transmission in 3-bit mode	MbitPrty = 1	48	50	_	μs
t <sub>r_OSS</sub>	Input rise time of OSS in 3-bit mode	0.8 → 2.3 V, MbitPrty = 1	1		300	ns
t <sub>f_OSS</sub>	Input fall time of OSS in 3-bit mode	1		300	ns	
t <sub>WDT_I2C</sub>	I <sup>2</sup> C Watchdog trip delay		1.1	2.2	3.3	s



# 6.7 Switching Characteristics

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$\delta I_{fault}$	Duty cycle of Iport with current fault		5.5%		6.7%	
		TOVLD = 00	50		70	
		TOVLD = 01	25		35	1
t <sub>OVLD</sub>	ICUT time limit (DCUTn = 0)	TOVLD = 10	100		140	ms
		TOVLD = 11	200		280	Ī
	ICUT Interrupt time limit when ICUT is disabled	I <sub>CUT</sub> limit exceeded but not I <sub>LIM</sub> , TLIM = 01, PoEPn =			4 . 0	
t <sub>ICUT_INT</sub>	(DCUTn = 1) <sup>(1)</sup>	1		LIM/2	t <sub>LIM/2</sub> + 6	ms
			50		70	1
		TLIM = 00, PoEPn = 1	50		70	Ī
$t_{LIM}$	ILIM time limit	TLIM = 01, PoEPn = 1	14.5	15	15.75	ms
		TLIM = 10, PoEPn = 1	11.5	12	12.5	Ī
		TLIM = 11, PoEPn = 1	9.5	10	10.5	L
		TSTART = 00	50		70	Ī
t <sub>START</sub>	Maximum current limit duration in port start-up	TSTART = 01	25		35	ms
		TSTART = 10	100		140	<u></u>
$t_{DET}$	Detection duration, 4-point discovery	Time to complete a detection	275	350	425	ms
	Detect backoff pause between discovery	$V_{VPWR} - V_{DRAINn} > 2.5 \text{ V}$	300	400	500	mo
<sup>t</sup> DET_BOFF	attempts	$V_{VPWR} - V_{DRAINn} < 2.5 V$	15		100	ms
$t_{DET\_DLY}$	Detection delay	From command or PD attachment to port detection complete			590	ms
$t_{CLE}$	Classification duration, first and second class event	Semiauto mode. From detection complete	6.5		12	ms
	Classification duration, 1-event physical layer	Semiauto mode. From detection complete	6.5		12	
t <sub>pdc</sub>	class timing	Manual mode. From beginning of class	6.5		14	ms
$t_{ME}$	Mark Duration, first and second mark event	Semiauto mode. From Class 4 complete	6		12	ms
•	Port Power-On delay, semiauto mode	From end of detection to port turn on using IEEE power enable			200	ms
t <sub>pon</sub>	Port Power-On delay, manual mode	From port turn on command to port turn on completed, four ports			4	ms
t <sub>RESET</sub>	Reset time duration from RESET pin		1		5	μs
$t_{\rm ed}$	Error delay timing. Delay before next attempt to power a port following power removal due to error condition	ICUT , ILIM or Ilnrush fault, semiauto mode	0.8	1	1.2	s
		TMPDO = 00	300		400	1
	<b>55</b>	TMPDO = 01	75		100	1
t <sub>MPDO</sub>	PD maintain power signature dropout time limit	TMPDO = 10	150		200	ms
		TMPDO = 11	600		800	Ī
t <sub>MPS</sub>	PD maintain power signature time for validity		13	15	17	ms
t <sub>D_off_OSS</sub>	Gate turn off time from 1-bit OSS input	From OSS to V <sub>GATEn</sub> < 1 V, V <sub>SENn</sub> = 0 V, MbitPrty = 0	1		5	μs
t <sub>OSS_OFF</sub>	Gate turn off time from 3-bit OSS input	From Start bit falling edge to $V_{GATEn} < 1 \text{ V}, V_{SENn} = 0$ V, MbitPrty = 1	72		104	μs
t <sub>P_off_CMD</sub>	Gate turn off time from port off command	From port off command to V <sub>GATEn</sub> < 1 V, V <sub>SENn</sub> = 0 V			300	μs
t <sub>P_off_RST</sub>	Gate turn off time with RESET	From RESET low to V <sub>GATEn</sub> < 1 V, V <sub>SENn</sub> = 0 V	1		5	μs
	Gate turn off time from SENn input	V <sub>DRAINn</sub> = 1 V , From V <sub>SENn</sub> pulsed to 0.425 V			0.9	
t <sub>D_off_SEN</sub>	Gate turn off time from SENn input (PoEPn = 1)	V <sub>DRAINn</sub> = 1 V , From V <sub>SENn</sub> pulsed to 0.62 V			0.9	μs
t <sub>POR</sub>	Device power-on reset delay	- ''			20	ms

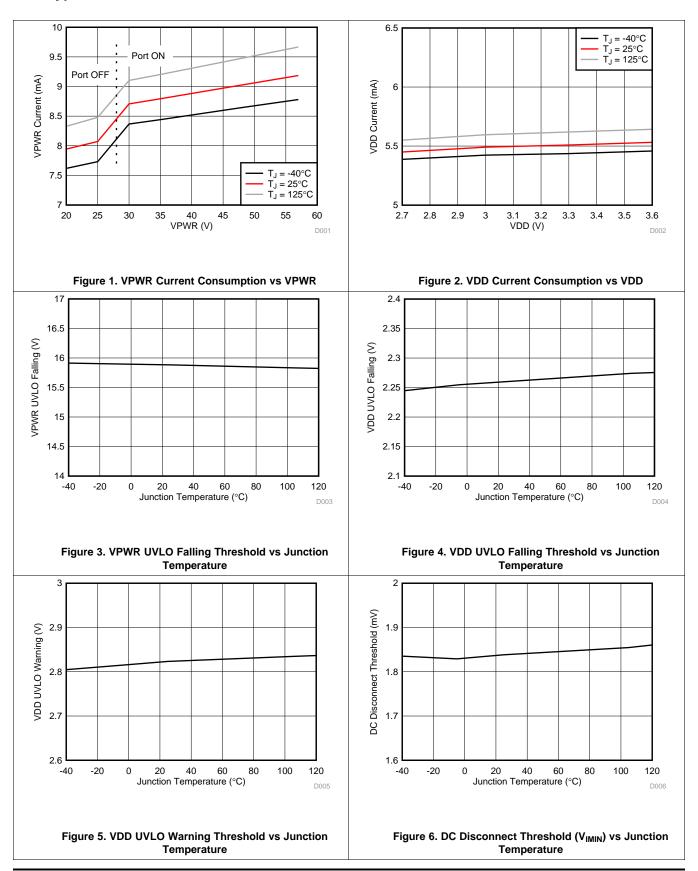
<sup>(1)</sup> The  $t_{\text{ICUT\_INT}}$  maximum value shown in the table only applies to a low percentage (< 10%) of occurence. The rest of the time, it becomes  $t_{\text{LIM}}/2 + 2$  ms.

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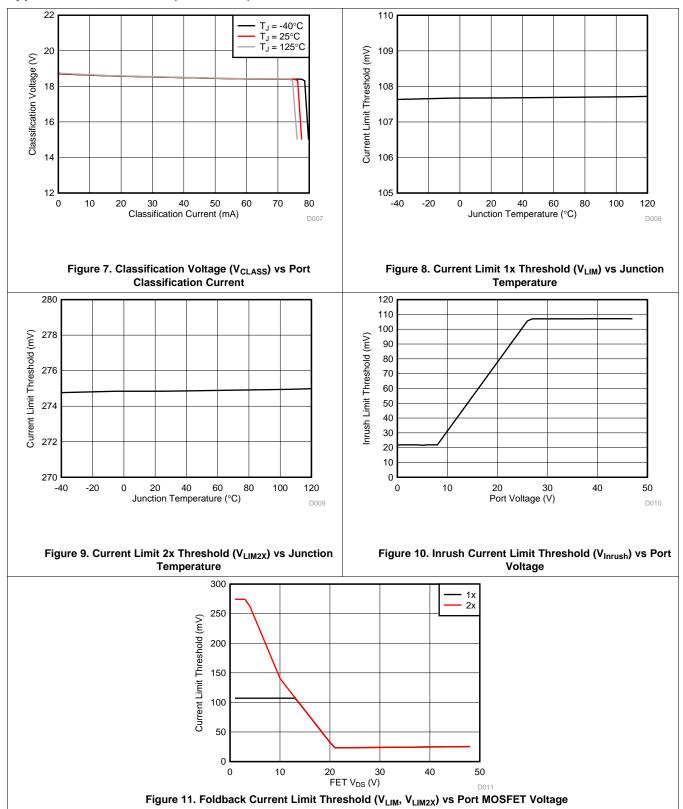
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### 6.8 Typical Characteristics





### **Typical Characteristics (continued)**





### 7 Parameter Measurement Information

# 7.1 Timing Diagrams

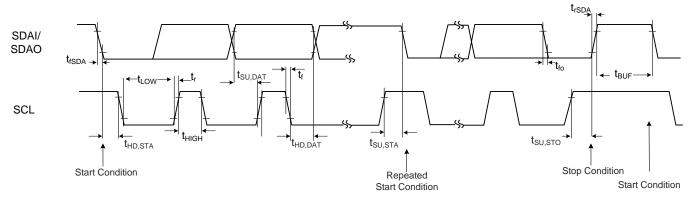


Figure 12. I<sup>2</sup>C Timings

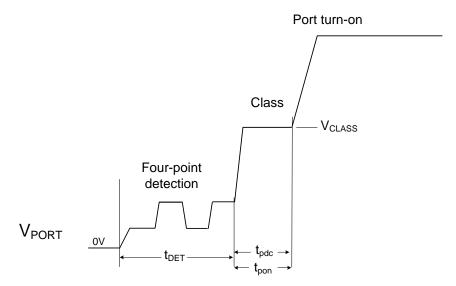


Figure 13. Detection, 1-Event Classification and Turn On



# **Timing Diagrams (continued)**

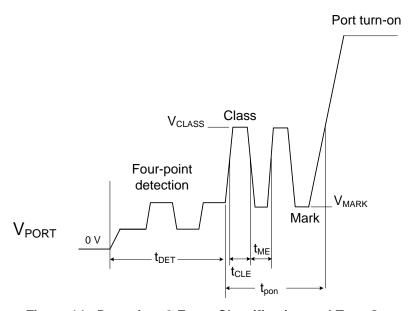


Figure 14. Detection, 2-Event Classification and Turn On

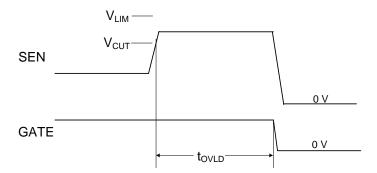


Figure 15. Overcurrent Fault Timing



### 8 Detailed Description

#### 8.1 Overview

The TPS2388 is an eight-port PSE for power over Ethernet applications. Each of the eight ports provides detection, classification, protection, and shut down in compliance with the IEEE 802.3at standard.

Basic PoE features include the following:

- · Performs high-reliability 4-point load detection
- Performs classification including type-2 (two-finger) of up to Class 4 loads
- Enables power with protective foldback current limiting, and adjustable I<sub>CUT</sub> threshold
- · Shuts down in the event of fault loads and shorts
- Performs maintain power signature function to ensure removal of power if load is disconnected
- Undervoltage lockout occurs if VPWR falls below VPUV\_F (typical 26.5 V).

Enhanced features include the following:

- Port re-mapping capability
- 8- and 16-bit access mode selectable
- 1- and 3-bit port shutdown priority
- Port turn ON command automatically supports IEEE TPON specification (0x23 register or 0x19 and 0x40 register)

Following a power-off command, disconnect, or shutdown due to a start, ICUT, or ILIM fault, the port powers down. Following port power off due to a power off command or disconnect, the TPS2388 restarts a detection cycle if commanded to do so. If the shutdown is due to a start, ICUT, or ILIM fault, the TPS2388 first enters into a cool-down period, at the end of this period the TPS2388 is able to restart the detection cycle.

Using the turn ON command supporting TPON, the TPS2388 will not automatically apply power to a port under the following circumstances:

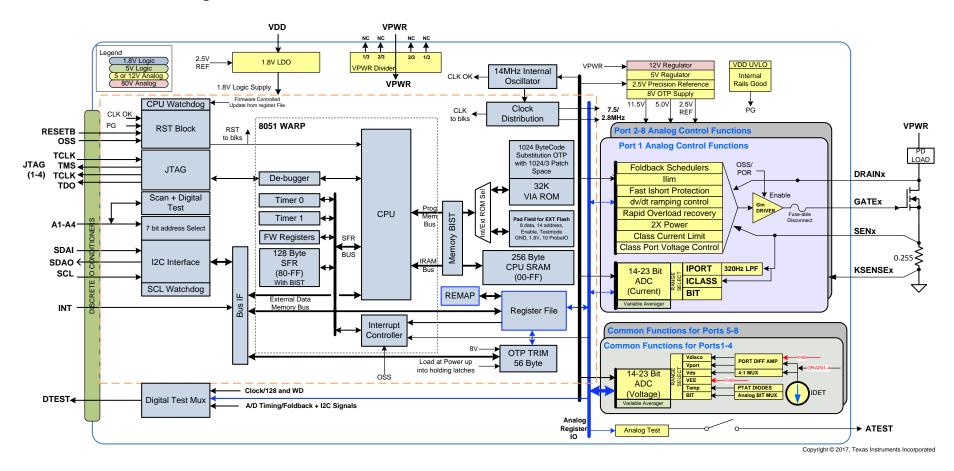
- · The detect status is not resistance valid.
- If the classification status is overcurrent, class mismatch, or unknown.

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### 8.2 Functional Block Diagram





### 8.3 Feature Description

### 8.3.1 Port Remapping

The TPS2388 provides port remapping capability, from the logical ports to the physical ports/pins.

The remapping is between any port of a 4-port group (1 to 4, 5 to 8).

The following example is applicable to 0x26 register = 00111001, 00111001b.

- Logical port 2 (6) ↔ Physical port 3 (7)

#### NOTE

The device ignores any remapping command unless all four ports are in off mode.

If the TPS2388 receives an incorrect configuration, it simply ignores the incorrect configuration and keeps the configuration unchanged. The ACK is also sent as usual at the end of communication. For example, if the same code is received for more than one port, then a read back of the Re-Mapping register (0x26) would be the last valid configuration.

Also note that if an IC reset command (1Ah register) is <u>received</u>, the port remapping configuration is kept unchanged. However, if there is a Power-on Reset or if the <u>RESET</u> pin is activated, the Re-Mapping register is reinitialized to a default value.

### 8.3.2 Port Power Priority

The TPS2388 supports 1- and 3-bit shutdown priority, selectable with the MbitPrty bit of General Mask register (0x17).

The 1-bit shutdown priority works with the Port Power Priority (0x15) register. An OSSn bit with a value of 1 indicates that the corresponding port will be treated as low priority, while a value of 0 corresponds to a high priority. As soon as the OSS input goes high, the low-priority ports are turned off.

The 3-bit shutdown priority works with the Multi Bit Power Priority (0x27/28) register, which holds the priority settings. A port with "000" code in this register has highest priority. Port priority reduces as the 3-bit value increases, with up to 8 priority levels. See Figure 16.

The port priority is defined as the following:

- OSS code ≤ Priority setting (0x27/28 register): OSS code turns off the port
- OSS code > Priority setting (0x27/28 register): OSS code has no impact on the port

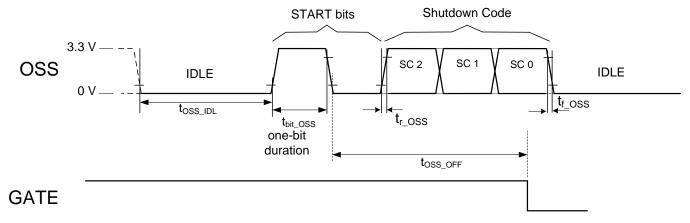


Figure 16. Multi-Bit Priority Port Shutdown if Lower-Priority Port



### **Feature Description (continued)**

#### **NOTE**

Prior to setting the MbitPrty bit from 0 to 1, make sure the OSS input is in the idle (low) state for a minimum of 200  $\mu$ s, to avoid any port misbehavior related to loss of synchronization with the OSS bit stream.

#### NOTE

The OSS input has an internal 1-µs to 5-µs deglitch filter. From the idle state, a pulse with a longer duration is interpreted as a valid start bit. Ensure that the OSS signal is noise free.

#### 8.3.3 A/D Converter

The TPS2388 features ten multi-slope integrating converters. Each of the first eight converters is dedicated to current measurement for one port and is operated independently to perform measurements in any of the following modes: classification and port powered. When the port is powered, the converter is used for current (100-ms averaged) monitoring, port policing, and DC disconnect. Each of the last two converters are shared within a group of four ports for discovery (16.6-ms averaged), port powered voltage monitoring, Power Good status, and FET short detection. It is also used for general-purpose measurements including input voltage (1 ms) and temperature.

The A/D converter type used in the TPS2388 differs from other similar types of converters in that it converts while the input signal is being sampled by the integrator, providing inherent filtering over the conversion period. The typical conversion time of the current converters is 800 µs, while it is 1 ms for the other converters. Powered-device detection is performed by averaging 16 consecutive samples providing significant rejection of noise at 50-Hz or 60-Hz line frequency. While a port is powered, digital averaging is used to provide a port current measurement integrated over a 100-ms time period. Note also that an anti-aliasing filter is present for port powered current monitoring.

#### NOTE

During port-powered mode, port current conversions are performed continuously. Also, in port-powered mode, the  $t_{START}$  timer must expire before any current or voltage A/D conversion can begin.

### 8.3.4 I<sup>2</sup>C Watchdog

An I<sup>2</sup>C Watchdog timer is available on the TPS2388 device. The timer monitors the I<sup>2</sup>C, SCL line for clock edges. When enabled, a timeout of the watchdog resets the I<sup>2</sup>C interface along with any active ports. This feature provides protection in the event of a hung software situation or I<sup>2</sup>C bus hang-up by slave devices. In the latter case, if a slave is attempting to send a data bit of 0 when the master stops sending clocks, then the slave could get stuck driving the data line low indefinitely. Because the data line is being driven low, the master cannot send a STOP to clean up the bus. Activating the I<sup>2</sup>C watchdog feature of the TPS2388 would clear this deadlocked condition. If the timer of 2 seconds expires, the ports latch off and the WD Status bit is set. Note that WD Status will be set even if the watchdog is not enabled. WD Status can only be cleared by a reset or writing a 0 to the WDS status bit location. The 4-bit watchdog disable field shuts down this feature when a code of 1011b is loaded. This field is preset to 1011b whenever the TPS2388 is initially powered. Also see *I2C WATCHDOG Register* for more details.

#### 8.3.5 Foldback Protection

The TPS2388 features two types of foldback protection mechanisms for complete MOSFET protection. During inrush at port turn on, the foldback is based on the port voltage as shown in Figure 17. Note that the inrush current profile remains the same, whatever the state of the PoEPn bit in the PoE Plus register.

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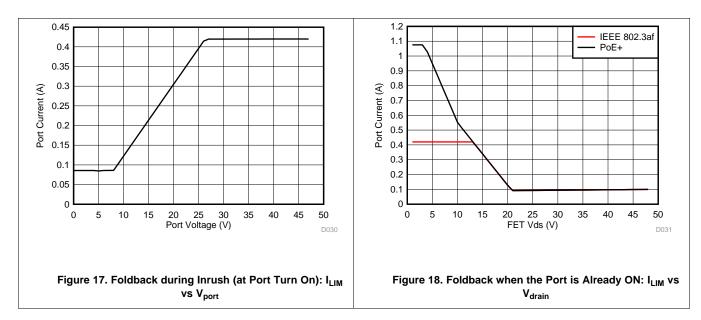
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### **Feature Description (continued)**

After the port has been turned on and the Power Good is valid, a dual-slope foldback is used, providing protection against partial and total short-circuit at port output, while still being able to maintain the PD powered during normal transients at the PSE input voltage. Note that setting the PoEPn bit selects the 2x curve and clearing it selects the 1x curve. See Figure 18.



#### 8.4 Device Functional Modes

#### 8.4.1 Port Operating Modes

#### 8.4.1.1 Semiauto

The port performs detection and classification (if valid detection occurs) continuously. Registers are updated each time a detection or classification occurs. The port power is not automatically turned on. Power Enable or IEEE Power Enable command is required to turn on the port.

#### 8.4.1.2 Manual

The port performs the functions indicated by its registers one time when commanded. There is no automatic state change.

#### 8.4.1.3 Power Off

The port is powered off and does not autonomously perform a detection, classification, or power-on. In this mode, Status and Enable bits for the associated port are reset.

#### 8.4.2 Detection

To eliminate the possibility of false detection, the TPS2388 uses a TI proprietary 4-point detection method to determine the signature resistance of the PD device. False detection of a  $25-k\Omega$  signature can occur with 2-point detection type PSEs in noisy environments or if the load is highly capacitive.

Both detection 1 and detection 2 are merged into a single detection function which is repeated. Detection 1 applies I1 (160  $\mu$ A) to a port, waits 60 ms, then measures the port voltage V1 with the integrating ADC. Detection 2 applies I2 (270  $\mu$ A) to a port, waits 60 ms, then measures the port voltage V2. The process is repeated a second time. Multiple comparisons and calculations are performed on all four measurement point combinations to eliminate the effects of a non-linear or hysteretic PD signature. The resulting port signature is then sorted into the appropriate category.

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### **Device Functional Modes (continued)**

#### NOTE

The detection resistance measurement result is also available in the Port Detect Resistance register.

#### 8.4.3 Classification

Hardware classification (class) is performed by supplying a voltage and sampling the resulting current. To eliminate the high power of a classification event from occurring in the power controller chip, the TPS2388 makes use of the external power FET for classification.

During classification, the voltage on the gate node of the external MOSFET is part of a linear control loop. The control loop applies the appropriate MOSFET drive to maintain a differential voltage between VPWR and DRAIN of 17.5 V. During classification the voltage across the sense resistor in the source of the MOSFET is measured and converted to a class level within the TPS2388. If a load short occurs during classification, the MOSFET gate voltage is quickly reduced to a linearly controlled, short-circuit value for the duration of the class event.

Classification results may be read through the I<sup>2</sup>C Detection Event and Port n Status Registers. The TPS2388 also supports two-event classification for type 2 PDs, using the IEEE Power Enable register.

#### 8.4.4 DC Disconnect

Disconnect is the automated process of turning off power to the port. When the port is unloaded or at least falls below minimum load, it is necessary to turn off power to the port and restart detection. In DC disconnect, the voltage across the sense resistors is measured. When enabled, the DC disconnect function monitors the sense resistor voltage of a powered port to verify the port is drawing at least the minimum current to remain active. The TDIS timer counts up whenever the port current is below a 7.5-mA threshold. If a timeout occurs, the port is shut down and the corresponding disconnect bit in the Fault Event Register is set. The TDIS counter is reset each time the current goes continuously higher than the disconnect threshold for nominally 15 ms.

The TDIS duration is set by the TMPDO Bits of the Timing Configuration register (0x16).

### 8.5 Programming

#### 8.5.1 I<sup>2</sup>C Serial Interface

The TPS2388 features a 3-wire I<sup>2</sup>C interface, using SDAI, SDAO, and SCL. Each transmission includes a Start condition sent by the master, followed by the device address (7-bit) with R/W bit, a register address byte, then one or two data bytes and a Stop condition. The recipient also sends an acknowledge bit following each byte transmitted. Also, SDAI/SDAO is stable while SCL is high except during a Start or Stop condition.

Figure 19 and Figure 20 illustrate read and write operations through I<sup>2</sup>C interface, using configuration A or B (see *Table 19* for more details). The 'parametric' read operation is applicable to A/D conversion results. The TPS2388 also features quick access to the latest addressed register through I<sup>2</sup>C bus. This means that when a Stop bit is received, the register pointer is not automatically reset.

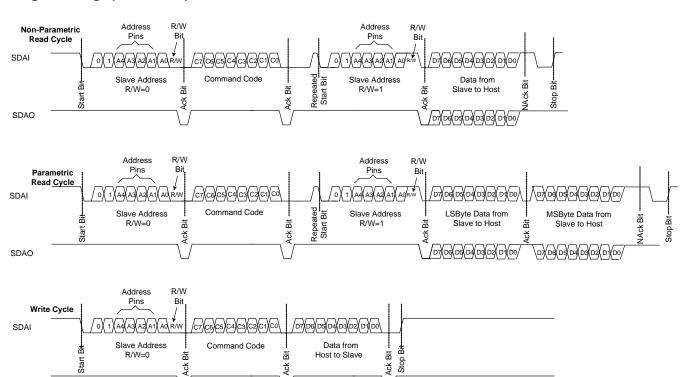
It is also possible to perform a write operation to many TPS2388 devices at the same time. The slave address during this broadcast access is 0x7F, as shown in *Pin Status Register*. Depending on which configuration (A or B) is selected, a global write proceeds as following:

- Config A: Both 4-port devices (1 to 4 and 5 to 8) are addressed at same time.
- Config B: The whole device is addressed.

SDAO



### **Programming (continued)**



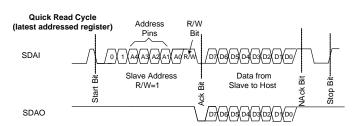
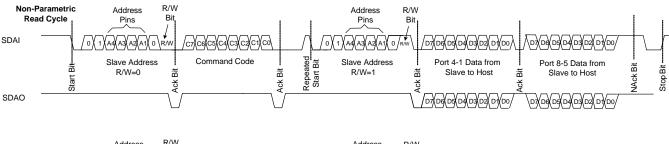
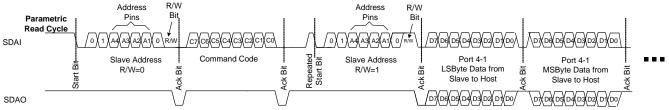


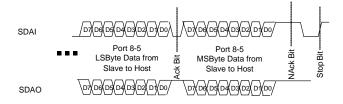
Figure 19. I<sup>2</sup>C interface Read and Write Protocol – Configuration A



### **Programming (continued)**







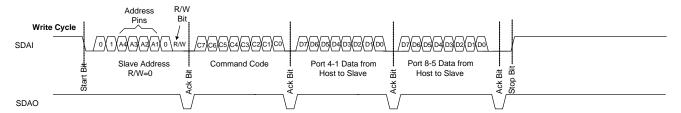


Figure 20. I<sup>2</sup>C interface Read and Write Protocol – Configuration B



# 8.6 Register Maps

### 8.6.1 Complete Register Set

Table 1. Main Registers

Cmd Code	Register or Command Name	I <sup>2</sup> C R/W	Data Byte	RST State				Bits Desc	ription				
INTERRU	PTS												
00h	INTERRUPT	RO	1	1000,0000b <sup>(1)</sup>	SUPF	STRTF	IFAULT	CLASC	DETC	DISF	PGC	PEC	
01h	INTERRUPT MASK	R/W	1	1000,0000b	SUMSK	STMSK	IFMSK	CLMSK	DEMSK	DIMSK	PGMSK	PEMSK	
EVENT						•							
02h	POWER EVENT	RO	1	d0000,0000b		Power Good sta	tus change			Power Enabl	e status change		
03h	POWER EVENT	CoR	1	0000,0000	PGC4	PGC3	PGC2	PGC1	PEC4	PEC3	PEC2	PEC1	
04h	DETECTION EVENT	RO	1	0000,0000b		Classifica	ation			De	tection		
05h	DETECTION EVENT	CoR	1	0000,0000	CLSC4	CLSC3	CLSC2	CLSC1	DETC4	DETC3	DETC2	DETC1	
06h	FAULT EVENT	RO	1	0000,0000b	Disc	connect occurred				ICUT fa	ult occurred		
07h	FAULT EVENT	CoR	1	0000,0000	DISF4	DISF3	DISF2	DISF1	ICUT4	ICUT3	ICUT2	ICUT1	
08h	START/ILIM EVENT	RO	1	0000,0000b		ILIM fault occurred				START fault occurred			
09h	START/ILIM EVENT	CoR	1	0000,0000	ILIM4	ILIM3	ILIM2	ILIM1	STRT4	STRT3	STRT2	STRT1	
0Ah	SUPPLY EVENT	RO	1	0111,0000b <sup>(2)</sup>	TSD	VDUV	VDWRN	VPUV	Rsvd	Rsvd	Rsvd	Rsvd	
0Bh	SUPPLY EVENT	CoR	1	0111,00005	130	VDOV	VDVVKIN	VPOV	Rsvu	KSVU	Rsvu	Ksvu	
STATUS													
0Ch	PORT 1 STATUS	RO	1	0000,0000b	Rsvd		CLASS Port 1			DETE	CT Port 1		
0Dh	PORT 2 STATUS	RO	1	0000,0000b	Rsvd		CLASS Port 2		DETECT Port 2				
0Eh	PORT 3 STATUS	RO	1	0000,0000b	Rsvd		CLASS Port 3		DETECT Port 3				
0Fh	PORT 4 STATUS	RO	1	0000,0000b	Rsvd		CLASS Port 4			DETE	CT Port 4		
10h	POWER STATUS	RO	1	0000,0000b	PG4	PG3	PG2	PG1	PE4	PE3	PE2	PE1	
11h	PIN STATUS	RO	1	0,A[4:0],0,0	Rsvd	SLA4	SLA3	SLA2	SLA1	SLA0	Rsvd	Rsvd	
CONFIGU	IRATION												
12h	OPERATING MODE	R/W	1	0000,0000b	Port 4 N	Mode	Port 3	Mode	Port 2	Mode	Port	1 Mode	
13h	DISCONNECT ENABLE	R/W	1	0000,0000b	Rsvd	Rsvd	Rsvd	Rsvd	DCDE4	DCDE3	DCDE2	DCDE1	
14h	DETECT/CLASS ENABLE	R/W	1	0000,0000b	CLE4	CLE3	CLE2	CLE1	DETE4	DETE3	DETE2	DETE1	
15h	PWRPR/ICUT DISABLE	R/W	1	0000,0000b	OSS4	OSS3	OSS2	OSS1	DCUT4	DCUT3	DCUT2	DCUT1	
16h	TIMING CONFIG	R/W	1	0000,0000b	TLIN	л	TST	ART	TO	VLD	TM	PDO	
17h	GENERAL MASK	R/W	1	1000,0000b	INTEN	Rsvd	nbitACC	MbitPrty	CLCHE	DECHE	R	svd	

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<sup>(1)</sup> SUPF bit reset state shown is at Power up only(2) VDUV, VPUV and VDWRN bits reset state shown is at Power up only



# **Register Maps (continued)**

### **Table 1. Main Registers (continued)**

Cmd Code	Register or Command Name	I <sup>2</sup> C R/W	Data Byte	RST State				Bits Desci	ription				
PUSH BU	TTONS												
18h	DETECT/CLASS Restart	WO	1	0000,0000b	RCL4	RCL3	RCL2	RCL1	RDET4	RDET3	RDET2	RDET1	
19h	POWER ENABLE	WO	1	0000,0000b	POFF4	POFF3	POFF2	POFF1	PWON4	PWON3	PWON2	PWON1	
1Ah	RESET	WO	1	0000,0000b	CLRAIN	CLINP	Rsvd	RESAL	RESP4	RESP3	RESP2	RESP1	
GENERAL	/SPECIALIZED		•										
1Bh	ID	RO	1	Mf[4:0],IC[2:0]		MFR ID					IC Version		
1Ch	Reserved	CoR	1	0000,0000b			Reserved				Reserved		
1Eh	POLICE 21 CONFIG	R/W	1	1111,1111b		POLICE P	ort 2			POLIC	E Port 1		
1Fh	POLICE 43 CONFIG	R/W	1	1111,1111b		POLICE P	ort 4			POLIC	E Port 3		
23h	IEEE Power Enable	WO	1	0000,0000b	T2PON4	T2PON3	T2PON2	T2PON1	T1PON4	T1PON3	T1PON2	T1PON1	
24h	Power-on FAULT	RO	1	d0000,0000b	PF Port	4	DE E	Port 3	DE	PF Port 2 PF Port 1		Port 1	
25h	FOWEI-OII FAULT	CoR	1	0000,0000	PF POIL	4	PFF	-011 3	PFF	OIL 2	FFI	-on i	
26h	RE-MAPPING	R/W	1	1110,0100b	Physical re-map Lo	ogical Port 4		ap Logical Port 3		map Logical Port Physical re-map Log		p Logical Port 1	
27h	Multi-bit Power Priority 21	R/W	1	0000,0000b	Rsvd		Port 2		Rsvd	Rsvd Port 1			
28h	Multi-bit Power Priority 43	R/W	1	0000,0000b	Rsvd		Port 4		Rsvd		Port 3		
29h-2Bh	Reserved	R/W	1	0000,0000b	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	Rsvd	
2Ch	TEMPERATURE	RO	1	0000,0000b				Temperature (	oits 7 to 0)				
2Eh	INPUT VOLTAGE	RO	2	0000,0000b				Input Voltage	: LSByte				
2Fh	INPUT VOLTAGE	RO	2	0000,0000b	Rsvd	Rsvd		I	nput Voltage: M	SByte (bits 13 to	8)		
EXTENDE	D REGISTER SET – PORT	PARAME	TRIC MEAS	SUREMENT									
30h	PORT 1 CURRENT	RO	2	0000,000b	Port 1 Current: LSByte								
31h	PORT I CURRENT	RO	2	0000,0000b	Rsvd Rsvd Port 1 Cu			ort 1 Current: M	Current: MSByte (bits 13 to 8)				
32h	PORT 1 VOLTAGE	RO	2	0000,000b				Port 1 Voltage	je: LSByte				
33h	FORTIVOLIAGE	RO		0000,000b	Rsvd	Rsvd		F	ort 1 Voltage: M	ISByte (bits 13 to	o 8)		



# Table 2. Main Registers

Cmd Code	Register or Command Name	I <sup>2</sup> C R/W	Data Byte	RST State				Bits De	escription			
34h	PORT 2 CURRENT	RO	2	0000,000b				Port 2 Cu	rrent: LSByte			
35h	PORT 2 CURRENT	RO	2	0000,0000b	Rsvd	Rsvd			Port 2 Current:	MSByte (bits 13 to	8)	
36h	PORT 2 VOLTAGE	RO	2	0000,000b		Port 2 Voltage: LSByte						
37h	PORT 2 VOLTAGE	RO	2	0000,0000b	Rsvd	Rsvd			Port 2 Voltage:	MSByte (bits 13 to	8)	
38h	PORT 3 CURRENT	RO	2	0000,000b				Port 3 cur	rrent: LSByte			
39h	FORT 3 CORRENT	RO	2	0000,0000b	Rsvd	Rsvd			Port 3 Current:	MSByte (bits 13 to	8)	
3Ah	PORT 3 VOLTAGE	RO	2	0000,0000b				Port 3 Vol	tage: LSByte			
3Bh	PORTS VOLTAGE	RO	2	0000,0000b	Rsvd	Rsvd			Port 3 Voltage:	MSByte (bits 13 to	0 8)	
3Ch	PORT 4 CURRENT	RO	2	0000,0000b				Port 4 cur	rrent: LSByte			
3Dh	PORT 4 CURRENT	RO	2	0000,0000b	Rsvd	Rsvd			Port 4 Current:	MSByte (bits 13 to	8)	
3Eh	PORT 4 VOLTAGE	RO	2	0000,0000b		Port 4 Voltage: LSByte						
3Fh	PORT 4 VOLTAGE	RO	2	0000,0000b	Rsvd	Rsvd			Port 4 Voltage:	MSByte (bits 13 to	0 8)	
CONFIGU	RATION/OTHERS	•										
40h	PoE PLUS	R/W	1	0000,0000b	PoEP4	PoEP3	PoEP2	PoEP1	Rsvd	Rsvd	Rsvd	TPON
41h	FIRMWARE REVISION	RO	1	RRRR,RRRRb		•		Firmwai	re Revision	•	•	
42h	I2C WATCHDOG	R/W	1	0001,0110b	Rsvd	Rsvd	Rsvd		Watchdo	og Disable		WDS
43h	DEVICE ID	RO	1	110,sr[4:0]	De	vice ID number			Sil	icon Revision num	ber	
PORT SIG	NATURE MEASUREMENTS	3										
44h	P1 DETECT RESISTANCE	RO	1	0000,0000b				Port 1 F	Resistance			
45h	P2 DETECT RESISTANCE	RO	1	0000,0000b	Port 2 Resistance							
46h	P3 DETECT RESISTANCE	RO	1	0000,0000b	Port 3 Resistance							
47h	P4 DETECT RESISTANCE	RO	1	0000,0000b	Port 4 Resistance							
48h-6Fh	Reserved	R/W	1	0000,000b				Res	served			



# Table 3. Registers Configuration A vs B

Cmd Code	Register or Command Name	Bits Description	Configuration A	Configuration B					
00h	INTERRUPT	INT bits P1-4, P5-8	Separate mask and interrupt result per group of 4 ports.						
01h	INTERRUPT MASK	MSK bits P1-4, P5-8	The Supply event bit is repeated twice.						
02h 03h	POWER EVENT	PGC_PEC P4-1, P8-5							
04h 05h	DETECTION EVENT	CLS_DET P4-1, P8-5							
06h 07h	FAULT EVENT DIS_ICUT P4-1, P8-5		Separate event byte per group of 4 ports.						
08h 09h	START/ILIM EVENT	ILIM_STR P4-1, P8-5							
0Ah 0Bh	SUPPLY EVENT	TSD, VDUV, VDUW, VPUV	Both 8-bit registers (port 1 to 4 and port 5 to 8) must show the Clearing at least one VPUV/VDUV also clears the other one.	e same result.					
0Ch	PORT 1 STATUS	CLS&DET1_CLS&DET5							
0Dh	PORT 2 STATUS	CLS&DET2_CLS&DET6	Caparata Status huta par part						
0Eh	PORT 3 STATUS	CLS&DET3_CLS&DET7	Separate Status byte per port						
0Fh	PORT 4 STATUS	CLS&DET4_CLS&DET8							
10h	POWER STATUS	PG_PE P4-1, P8-5	Separate status byte per group of 4 ports						
11h	PIN STATUS	A4-A1,A0	Both 8-bit registers (port 1 to 4 and port 5 to 8) must show the <b>same</b> result, except that A0 = 0 (port 1 to 4) or 1 (port 5 to 8).	Both 8-bit registers (port 1 to 4 and port 5 to 8) must show the <b>same</b> result, including A0 = 0.					
12h	OPERATING MODE	MODE P4-1, P8-5	Separate Mode byte per group of 4 ports.						
13h	DISCONNECT ENABLE	DCDE P4-1, P8-5	Separate DC disconnect enable byte per group of 4 ports.						
14h	DETECT/CLASS ENABLE	CLE_DETE P4-1, P8-5	Separate Detect/Class Enable byte per group of 4 ports.						
15h	PWRPR/ICUT DISABLE	OSS_DCUT P4-1, P8-5	Separate OSS/DCUT byte per group of 4 ports.						
16h	TIMING CONFIG	TLIM_TSTRT_TOVLD_TMPDO P4-1, P8-5	Separate Timing byte per group of 4 ports.						
17h	GENERAL MASK	P4-1, P8-5 including n-bit access	Separate byte per group of 4 ports.  n-bit access: Setting this in at least one of the virtual quad reg config A, clear both.  MbitPrty: Setting this in at least one of the virtual quad registe to 1-bit shutdown, clear both MbitPrty bits.	gister space is enough to enter Config B mode. To go back to er space is enough to enter 3-bit shutdown priority. To go back					
18h	DETECT/CLASS Restart	RCL_RDET P4-1, P8-5	Separate DET/CL RST byte per group of 4 ports						
19h	POWER ENABLE	POF_PWON P4-1, P8-5	Separate POF/PWON byte per group of 4 ports						
1Ah	RESET	P4-1, P8-5	Separate byte per group of 4 ports, Clear Int pin and Clear All int.  However, If at least one of the IC reset bits is set – the whole chip has a POR.	following bit is set for one 4-port group, the corresponding					
1Bh	ID		Both 8-bit registers (port 1 to 4 and port 5 to 8) must show the	e same result unless modified through I <sup>2</sup> C.					



# Table 3. Registers Configuration A vs B (continued)

Cmd Code	Register or Command Name	Bits Description	Configuration A	Configuration B			
1Eh	POLICE 21 CONFIG	POL2&1, POL6&5	Separate Policing byte per group of 2 ports.				
1Fh	POLICE 43 CONFIG	POL4&3, POL8&7	Separate Folicing byte per group of 2 ports.				
23h	IEEE Power Enable	T2P_T1P P4-1, P8-5	Separate IEEE Power Enable byte per group of 2 ports				
24h 25h	Power-on FAULT	PF P4-1, P8-5	Separate Power-on FAULT byte per group of 4 ports				
26h	PORT REMAPPING	Logical P4-1, P8-5	Separate Remapping byte per group of 4 ports.  Reinitialized only if POR or RESET pin. Kept unchanged if	0x1A IC reset or CPU watchdog reset.			
2Ch	TEMPERATURE	TEMP P1-4, P5-8	Both 8-bit registers (port 1 to 4 and port 5 to 8) must show	the <b>same</b> result.			
2Eh 2Fh	INPUT VOLTAGE	VPWR P1-4, P5-8	Both 8-bit registers (port 1 to 4 and port 5 to 8) must show the <b>same</b> result.				
30h	PORT 1 CURRENT	11, 15	Separate 2-byte per group of 4 ports	Separate 2-byte per group of 4 ports. 2-byte Read at 0x30 gives I1 4-byte Read at 0x30 gives I1, I5.			
31h	1		N/A	2-byte Read at 0x31 gives I5.			
32h	PORT 1 VOLTAGE	V1, V5	Separate 2-byte per group of 4 ports	2-byte Read at 0x32 gives V1 4-byte Read at 0x32 gives V1, V5.			
33h			N/A	2-byte Read at 0x33 gives V5.			
34h	PORT 2 CURRENT	12, 16	Separate 2-byte per group of 4 ports	2-byte Read at 0x34 gives I2 4-byte Read at 0x34 gives I2, I6.			
35h			N/A	2-byte Read at 0x35 gives I6.			
36h	PORT 2 VOLTAGE	V2, V6	Separate 2-byte per group of 4 ports	2-byte Read at 0x36 gives V2 4-byte Read at 0x36 gives V2, V6.			
37h			N/A	2-byte Read at 0x37 gives V6.			
38h	PORT 3 CURRENT	13, 17	Separate 2-byte per group of 4 ports	2-byte Read at 0x38 gives I3 4-byte Read at 0x38 gives I3, I7.			
39h	1		N/A	2-byte Read at 0x39 gives I7.			
3Ah	PORT 3 VOLTAGE	V3, V7	Separate 2-byte per group of 4 ports	2-byte Read at 0x3A gives V3 4-byte Read at 0x3A gives V3, V7.			
3Bh			N/A	2-byte Read at 0x3B gives V7.			
3Ch	PORT 4 CURRENT	14, 18	Separate 2-byte per group of 4 ports	2-byte Read at 0x3C gives I4 4-byte Read at 0x3C gives I4, I8.			
3Dh	1		N/A	2-byte Read at 0x3D gives I8.			
3Eh	PORT 4 VOLTAGE	V4, V8	Separate 2-byte per group of 4 ports	2-byte Read at 0x3E gives V4 4-byte Read at 0x3E gives V4, V8.			
3Fh			N/A	2-byte Read at 0x3F gives V8.			
40h	PoE PLUS	PoEP_TPON, P4-1, P8-5	TPON setting: separate setting per group of 4 ports. Separate PoEP config byte per group of 4 ports.	•			
41h	FIRMWARE REVISION	FRV P1-4, P5-8	Both 8-bit registers (port 1 to 4 and port 5 to 8) must show	the same result.			



# Table 3. Registers Configuration A vs B (continued)

Cmd Code	Register or Command Name	Bits Description	Configuration A	Configuration B
42h	I2C WATCHDOG	P1-4, P5-8	IWD3-0: if at least one of the two 4-port settings is different tha WDS: Both 8-bit registers (port 1 to 4 and port 5 to 8) must she individually through I <sup>2</sup> C.	
43h	DEVICE ID	DID_SR P1-4, P5-8	Both 8-bit registers (port 1 to 4 and port 5 to 8) must show the	same result unless modified through I <sup>2</sup> C.
44h	PORT 1 RESISTANCE	RDET1, RDET5		
45h	PORT 2 RESISTANCE	RDET2, RDET6	Separate byte per port.	
46h	PORT 3 RESISTANCE	RDET3, RDET7	Detection resistance always updated, detection good or bad.	
47h	PORT 4 RESISTANCE	RDET4, RDET8		



### 8.6.2 INTERRUPT Register

COMMAND = 00h with 1 Data Byte, Read only

Active high, each bit corresponds to a particular event that occurred. Each bit can be individually reset by doing a read at the corresponding event register address, or by setting bit 7 of Reset register.

Any active bit of Interrupt register activates the  $\overline{\text{INT}}$  output if its corresponding Mask bit in INTERRUPT Mask register (01h) is set, as well as the INTEN bit in the General Mask register.

Figure 21. INTERRUPT Register Format

7	6	5	4	3	2	1	0
SUPF	STRTF	IFAULT	CLASC	DETC	DISF	PGC	PEC
R-1	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

### **Table 4. INTERRUPT Register Field Descriptions**

		_		. INTERROFT Register Field Descriptions
Bit	Field	Type	Reset	Description
7	SUPF	R	1	Indicates that a Supply Event Fault occurred  SUPF = TSD    VDUV    VPUV
				1 = At least one Supply Event Fault occurred
				0 = No such event occurred
6	STRTF	R	0	Indicates that a t <sub>START</sub> Fault occurred on at least one port.  STRTF = STRT1    STRT2    STRT3    STRT4
				1 = t <sub>START</sub> Fault occurred for at least one port
				0 = No t <sub>START</sub> Fault occurred
5	IFAULT	R	0	Indicates that a t <sub>OVLD</sub> or t <sub>LIM</sub> Fault occurred on at least one port.  IFAULT = ICUT1    ICUT2    ICUT3    ICUT4    ILIM1    ILIM2    ILIM3    ILIM4
				1 = t <sub>OVLD</sub> and/or t <sub>LIM</sub> Fault occurred for at least one port
				0 = No t <sub>OVLD</sub> nor t <sub>LIM</sub> Fault occurred
4	CLASC	R	0	Indicates that at least one classification cycle occurred on at least one port
				CLASC = CLSC1    CLSC2    CLSC3    CLSC4
				1 = At least one classification cycle occurred for at least one port
				0 = No classification cycle occurred
3	DETC	R	0	Indicates that at least one detection cycle occurred on at least one port
				DETC = DETC1    DETC2    DETC3    DETC4
				1 = At least one detection cycle occurred for at least one port
				0 = No detection cycle occurred
2	DISF	R	0	Indicates that a disconnect event occurred on at least one port.  DISF = DISF1    DISF2    DISF3    DISF4
				1 = Disconnect event occurred for at least one port
				0 = No disconnect event occurred
1	PGC	R	0	Indicates that a power good status change occurred on at least one port.
				PGC = PGC1    PGC2    PGC3    PGC4
				1 = Power good status change occurred on at least one port
				0 = No power good status change occurred
0	PEC	R	0	Indicates that a power enable status change occurred on at least one port PEC = PEC1    PEC2    PEC3    PEC4
				1 = Power enable status change occurred on at least one port
				0 = No power enable status change occurred
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#### 8.6.3 INTERRUPT MASK Register

COMMAND = 01h with 1 Data Byte, Read/Write

Each bit corresponds to a particular event or fault as defined in the Interrupt register.

Writing a 0 into a bit will mask the corresponding event/fault from activating the INT output.

Note that the bits of the Interrupt register always change state according to events or faults, regardless of the state of the Interrupt Mask register.

Note that the INTEN bit of the General Mask register must also be set in order to allow an event to activate the INT output.

Figure 22. INTERRUPT MASK Register Format

7	6	5	4	3	2	1	0
SUMSK	STMSK	IFMSK	CLMSK	DEMSK	DIMSK	PGMSK	PEMSK
R/W-1	R/W-0						

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

### **Table 5. INTERRUPT MASK Register Field Descriptions**

Bit	Field	Туре	Reset	Description
7	SUMSK	R/W	1	Supply Event Fault mask bit.
				1 = Supply Event Fault will activate the $\overline{\text{INT}}$ output.
				$0 = $ Supply Event Fault will have no impact on $\overline{INT}$ output.
6	STMSK	R/W	0	t <sub>START</sub> Fault mask bit.
				1 = t <sub>START</sub> Fault will activate the INT output.
				0 = t <sub>START</sub> Fault will have no impact on INT output.
5	IFMSK	R/W	0	tOVLD or LIM Fault mask bit.
				1 = $t_{OVLD}$ and/or $t_{LIM}$ Fault occurrence will activate the $\overline{INT}$ output
				$0 = t_{OVLD}$ and/or $t_{LIM}$ Fault occurrence will have no impact on $\overline{INT}$ output
4	CLMSK	R/W	0	Classification cycle mask bit.
				1 = Classification cycle occurrence will activate the $\overline{\text{INT}}$ output.
				$0 = Classification$ cycle occurrence will have no impact on $\overline{INT}$ output.
3	DEMSK	R/W	0	Detection cycle mask bit.
				1 = Detection cycle occurrence will activate the INT output.
				$0 = Detection cycle occurrence will have no impact on \overline{INT} output.$
2	DIMSK	R/W	0	Disconnect event mask bit.
				1 = Disconnect event occurrence will activate th INT output.
				0 = Disconnect event occurrence will have no impact on INT output.
1	PGMSK	R/W	0	Power good status change mask bit.
				1 = Power good status change will activate the INT output.
				$0 = $ Power good status change will have no impact on $\overline{\text{INT}}$ output.
0	PEMSK	R/W	0	Power enable status change mask bit.
				1 = Power enable status change will activate the INT output.
				0 = Power enable status change will have no impact on INT output.

#### NOTE

If SUMSK = 0, a VPWR undervoltage Event Fault (VPUV) will also **not** shut off ports, as long as VPWR is above the VPWR UVLO threshold.

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### 8.6.4 POWER EVENT Register

COMMAND = 02h with 1 Data Byte, Read only

COMMAND = 03h with 1 Data Byte, Clear on Read

Active high, each bit corresponds to a particular event that occurred.

Each bit xxx1-4 represents an individual port.

A read at each location (02h or 03h) returns the same register data with the exception that the Clear on Read command clears all bits of the register.

If this register is causing the  $\overline{\text{INT}}$  pin to be activated, this Clear on Read will release the  $\overline{\text{INT}}$  pin.

Any active bit will have an impact on the Interrupt register as indicated in the Interrupt register description.

Figure 23. POWER EVENT Register Format

7	6	5	4	3	2	1	0
PGC4	PGC3	PGC2	PGC1	PEC4	PEC3	PEC2	PEC1
R-0							
CR-0							

LEGEND: R/W = Read/Write; R = Read only; ; CR = Clear on Read, -n = value after reset

### Table 6. POWER EVENT Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–4	PGC4-PGC1	R or	0	Indicates that a power good status change occurred.
		CR		1 = Power good status change occurred
				0 = No power good status change occurred
3–0	PEC4-PEC1			Indicates that a power enable status change occurred.
	CR		1 = Power enable status change occurred	
				0 = No power enable status change occurred

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#### 8.6.5 DETECTION EVENT Register

COMMAND = 04h with 1 Data Byte, Read only

COMMAND = 05h with 1 Data Byte, Clear on Read

Active high, each bit corresponds to a particular event that occurred.

Each bit xxx1-4 represents an individual port.

A read at each location (04h or 05h) returns the same register data with the exception that the Clear on Read command clears all bits of the register. These bits are cleared when port n is turned off.

If this register is causing the  $\overline{\text{INT}}$  pin to be activated, this Clear on Read will release the  $\overline{\text{INT}}$  pin.

Any active bit will have an impact on the Interrupt register as indicated in the Interrupt register description.

### Figure 24. DETECTION EVENT Register Format

7	6	5	4	3	2	1	0
CLSC4	CLSC3	CLSC2	CLSC1	DETC4	DETC3	DETC2	DETC1
R-0							
CR-0							

LEGEND: R/W = Read/Write; R = Read only; ; CR = Clear on Read, -n = value after reset

#### Table 7. DETECTION EVENT Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–4	CLSC4-CLSC1	R or CR	0	Indicates that at least one classification cycle occurred if the CLCHE bit in General Mask register is low. Conversely, it indicates when a change of class occurred if the CLCHE bit is set.
				1 = At least one classification cycle occurred (if CLCHE = 0) or a change of class occurred (CLCHE = 1)
				0 = No classification cycle occurred (if CLCHE = 0) or no change of class occurred (CLCHE = 1)
3–0	DETC4-DETC1	R or CR	0	Indicates that at least one detection cycle occurred if the DECHE bit in General Mask register is low. Conversely, it indicates when a change in detection occurred if the DECHE bit is set.
				1 = At least one detection cycle occurred (if DECHE = 0) or a change in detection occurred (DECHE = 1)
				0 = No detection cycle occurred (if DECHE = 0) or no change in detection occurred (DECHE = 1)



#### 8.6.6 FAULT EVENT Register

COMMAND = 06h with 1 Data Byte, Read only

COMMAND = 07h with 1 Data Byte, Clear on Read

Active high, each bit corresponds to a particular event that occurred.

Each bit xxx1-4 represents an individual port.

A read at each location (06h or 07h) returns the same register data with the exception that the Clear on Read command clears all bits of the register. These bits are cleared when port n is turned off.

If this register is causing the INT pin to be activated, this Clear on Read will release the INT pin.

Any active bit will have an impact on the Interrupt register as indicated in the Interrupt register description.

Figure 25. FAULT EVENT Register Format

7	6	5	4	3	2	1	0
DISF4	DISF3	DISF2	DISF1	ICUT4	ICUT3	ICUT2	ICUT1
R-0							
CR-0							

LEGEND: R/W = Read/Write; R = Read only; ; CR = Clear on Read, -n = value after reset

Table 8. FAULT EVENT Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–4	DISF4-DISF1	R or	0	Indicates that a disconnect event occurred.
		CR		1 = Disconnect event occurred
				0 = No disconnect event occurred
3–0	ICUT4-ICUT1	R or	0	Indicates that a t <sub>OVLD</sub> Fault occurred.
		CR	1 = t <sub>OVLD</sub> Fault occurred	
				0 = No t <sub>OVLD</sub> Fault occurred

Note that if ICUT is disabled for a port, this port will not be automatically turned off during an ICUT fault condition. However, the ICUT fault flag will still be operational, with a fault timeout equal to  $t_{LIM}$  / 2.

Also, if a Clear on Read is done at the Fault Event register, not only the ICUTn bit is reset, but the associated port ICUT counter is also reset.

Note that this has no impact on TLIM counter at all.

In any other case, ICUT fault is related to TOVLD fault timer as usual and there is no counter reset during clear on read operation.

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#### 8.6.7 START/ILIM EVENT Register

COMMAND = 08h with 1 Data Byte, Read only

COMMAND = 09h with 1 Data Byte, Clear on Read

Active high, each bit corresponds to a particular event that occurred.

Each bit xxx1-4 represents an individual port.

A read at each location (08h or 09h) returns the same register data with the exception that the Clear on Read command clears all bits of the register. These bits are cleared when port n is turned off.

If this register is causing the  $\overline{\rm INT}$  pin to be activated, this Clear on Read will release the  $\overline{\rm INT}$  pin.

Any active bit will have an impact on the Interrupt register as indicated in the Interrupt register description.

Note: When a Start Fault is reported after the IEEE Power Enable command is used, if the PECn bit in Power Event register is set, then there is an Inrush fault. If PECn bit is not set, then the Power-On Fault register indicates the cause of the fault.

Figure 26. START/ILIM EVENT Register Format

7	6	5	4	3	2	1	0
ILIM4	ILIM3	ILIM2	ILIM1	STRT4	STRT3	STRT2	STRT1
R-0							
CR-0							

LEGEND: R/W = Read/Write; R = Read only; ; CR = Clear on Read, -n = value after reset

### Table 9. START/ILIM EVENT Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–4	ILIM4–ILIM1	R or CR	0	Indicates that a $t_{\text{LIM}}$ fault occurred, which means the port has limited its output current to $l_{\text{LIM}}$ or the folded back $l_{\text{LIM}}$ for more than $t_{\text{LIM}}$ .
				1 = t <sub>LIM</sub> fault occurred
				0 = No t <sub>LIM</sub> fault occurred
3–0	STRT4-STRT1	R or CR	0	Indicates that a t <sub>START</sub> fault occurred at port turn on. Also indicates if a class or detection error occurred during a port turn on using the IEEE Power Enable command.
				1 = t <sub>START</sub> fault or class/detect error occurred
				0 = No t <sub>START</sub> fault or class/detect error occurred



#### 8.6.8 SUPPLY EVENT Register

COMMAND = 0Ah with 1 Data Byte, Read only

COMMAND = 0Bh with 1 Data Byte, Clear on Read

Active high, each bit corresponds to a particular event that occurred.

Each bit D3, D2, D1, and D0 are reserved for future use.

A read at each location (0Ah or 0Bh) returns the same register data with the exception that the Clear on Read command clears all bits of the register.

If this register is causing the  $\overline{\rm INT}$  pin to be activated, this Clear on Read will release the  $\overline{\rm INT}$  pin.

Any active bit will have an impact on the Interrupt register as indicated in the Interrupt register description.

Figure 27. SUPPLY EVENT Register Format

7	6	5	4	3	2	1	0
TSD	VDUV	VDWRN	VPUV	_	1	1	-
R	R	R	R	R	R	R	R
CR	CR	CR	CR	CR	CR	CR	CR

LEGEND: R/W = Read/Write; R = Read only; ; CR = Clear on Read, -n = value after reset

Table 10. SUPPLY EVENT Register Field Descriptions

Bit	Field	Туре	POR	Description						
7	TSD	R or CR	0	Indicates that a thermal shutdown occurred. When there is thermal shutdown, all ports are turned off and are put in OFF mode. The TPS2388 internal circuitry continues to operate however, including the A/D converters. Note that at as soon as the internal temperature has decreased below the low threshold, the ports can be turned back ON regardless of the status of the TSD bit.						
				1 = Thermal shutdown occurred						
				0 = No thermal shutdown occurred						
6	VDUV			Indicates that a VDD UVLO occurred.						
		CR		1 = VDD UVLO occurred						
				0 = No VDD UVLO occurred						
5	VDWRN	R or	1	Indicates that the VDD has fallen under the UVLO warning threshold.						
		CR	R	CR	CR	CR	CR	CR		1 = VDD UV Warning occurred
				0 = No VDD UV warning occurred						
4	4 VPUV R or CR 1 Indicates Indicates that a VPWR undervoltage occurre 1 = VPWR undervoltage occurred		Indicates Indicates that a VPWR undervoltage occurred.							
				1 = VPWR undervoltage occurred						
				0 = No VPWR undervoltage occurred						

Note: Pulling RESET input low will not clear VDUV or VPUV.

When VPWR undervoltage occurs, all ports are shut off if SUMSK = 1. If VPWR UVLO or VDD UVLO occurs, there is power-on reset. Note also that turning OFF a port when VPWR undervoltage occurs also clears the corresponding bits in Fault Event register (DISFn, ICUTn), Start Event register (STRTn), Port n Status register (CLASS Pn, DETECT Pn), DETECT/CLASS ENABLE register (CLEn, DETEn) and Power-on Fault register (PFn). The corresponding PGCn and PECn bits of Power Event register will also be set if there is a change. The corresponding PEn and PGn bits of Power Status Register are also updated accordingly.

### NOTE

A clear on Read will not effectively clear VDUV bit as long as the VPWR undervoltage condition is maintained.

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#### **NOTE**

If SUMSK = 0, a VPWR undervoltage Event Fault (VPUV) will not shut off ports, as long as VPWR is above the VPWR UVLO threshold.

#### **NOTE**

During VPWR undervoltage, the Detection Event register (CLSCn, DETCn) is not cleared, unless VPWR also falls below the VPWR UVLO falling threshold.

#### **NOTE**

If VPWR UVLO or VDD UVLO occurs, the I<sup>2</sup>C interface stops operating, and SDAO is forced low.



#### 8.6.9 PORT 1 STATUS Register

COMMAND = 0Ch with 1 Data Byte, Read Only

## Figure 28. PORT 1 STATUS Register Format

7	6	5	4	3	2	1	0
_		CLASS P1		DETECT P1			
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 8.6.10 PORT 2 STATUS Register

COMMAND = 0Dh with 1 Data Byte, Read Only

## Figure 29. PORT 2 STATUS Register Format

7	6	5	4	3	2	1	0
_		CLASS P2		DETECT P2			
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### 8.6.11 PORT 3 STATUS Register

COMMAND = 0Eh with 1 Data Byte, Read Only

## Figure 30. PORT 3 STATUS Register Format

7	6	5	4	3	2	1	0
_		CLASS P3		DETECT P3			
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### 8.6.12 PORT 4 STATUS Register

COMMAND = 0Fh with 1 Data Byte, Read Only

#### Figure 31. PORT 4 STATUS Register Format

7	6	5	4	3	2	1	0	
_		CLASS P4		DETECT P4				
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Bit Descriptions: These bits represent the most recent classification and detection results for port n. These bits are cleared when port n is turned off.

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# **Table 11. PORT STATUS Register Field Descriptions**

Bit	Field	Туре	Reset		Description							
7	_	R	0	R	eserved							
6–4	CLASS Pn	R	0	М	Most recent classification result on port n.							
				Tł	ne sele	ction is	as follo	owing:				
					С	LASS	Pn	Class	Status			
					0	0	0	Unkno	own			
					0	0	1	Class	1			
					0	1	0	Class	2			
					0	1	1	Class	3			
					1	0	0	Class	4			
					1	0	1	Reser	ved – read as Class 0			
					1	1	0	Class	0			
					1	1	1	Overd	Overcurrent			
3–0	DETECT Pn	R	0	М	ost rec	ent det	ection i	esult o	n port n.			
				Ti	ne sele	ction is	as follo	owing:				
						DETE	CT Pn		Class Status			
					0	0	0	0	Unknown			
					0	0	0	1	Short-circuit			
					0	0	1	0	Reserved			
					0	0	1	1	1 Too Low			
					0	1	0	0	0 Valid			
					0	1	0	1	Too High			
					0	1	1	0	Open Circuit			
					0	1	1	1	Reserved			
					1	1	1	0	MOSFET fault			



## 8.6.13 POWER STATUS Register

COMMAND = 10h with 1 Data Byte, Read only

Each bit represents the actual power status of a port.

Each bit xx1-4 represents an individual port..

These bits are cleared when port n is turned off, including if the turn off is caused by a fault condition.

## Figure 32. POWER STATUS Register Format

7	6	5	4	3	2	1	0
PG4	PG3	PG2	PG1	PE4	PE3	PE2	PE1
R-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## **Table 12. POWER STATUS Register Field Descriptions**

Bit	Field	Туре	Reset	Description
7–4	PG4-PG1	R	0	Each bit, when at 1, indicates that the port is on and that the voltage at DRAINn pin has gone below the power good threshold during the port turn on.
				These bits are latched high once the turn on is complete and can only be cleared when the port is turned off or at RESET/POR.
				1 = Power is good
				0 = Power is not good
3–0	PE4-PE1	R	0	Each bit indicates the ON/OFF state of the corresponding port.
				1 = Port is on
				0 = Port is off

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## 8.6.14 Pin Status Register

COMMAND = 11h with 1 Data Byte, Read Only

Figure 33. Pin Status Register Format

7	6	5	4	3	2	1	0
0	SLA4	SLA3	SLA2	SLA1	SLA0	0	0
0	A4 pin	A3 pin	A2 pin	A1 pin	0/1 (1)	0	0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

(1) If Configuration A, it can be 0 or 1. If configuration B, it is 0.

## Table 13. Pin Status Register Field Descriptions

Bit	Field	Туре	Reset	Description
6-2	SLA4-SLA0	R	See above	I <sup>2</sup> C device address, as defined while using pins A4-A1. SLA0 is internally defined as 0 or 1.

DECODIDEION			BINARY	DEVICE A	DDRESS				ADDRE	SS PINS	
DESCRIPTION	6	5	4	3	2	1	0	A4	А3	A2	A1
Broadcast access	1	1	1	1	1	1	1	Х	Х	Х	Х
Slave 0	0	1	0	0	0	0	0/1	GND	GND	GND	GND
	0	1	0	0	0	1	0/1	GND	GND	GND	HIGH
	0	1	0	0	1	0	0/1	GND	GND	HIGH	GND
	0	1	0	0	1	1	0/1	GND	GND	HIGH	HIGH
	0	1	0	1	0	0	0/1	GND	HIGH	GND	GND
	0	1	0	1	0	1	0/1	GND	HIGH	GND	HIGH
	0	1	0	1	1	0	0/1	GND	HIGH	HIGH	GND
	0	1	0	1	1	1	0/1	GND	HIGH	HIGH	HIGH
	0	1	1	0	0	0	0/1	HIGH	GND	GND	GND
	0	1	1	0	0	1	0/1	HIGH	GND	GND	HIGH
	0	1	1	0	1	0	0/1	HIGH	GND	HIGH	GND
	0	1	1	0	1	1	0/1	HIGH	GND	HIGH	HIGH
	0	1	1	1	0	0	0/1	HIGH	HIGH	GND	GND
	0	1	1	1	0	1	0/1	HIGH	HIGH	GND	HIGH
	0	1	1	1	1	0	0/1	HIGH	HIGH	HIGH	GND
Slave 15	0	1	1	1	1	1	0/1	HIGH	HIGH	HIGH	HIGH

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#### 8.6.15 OPERATING MODE Register

COMMAND = 12h with 1 Data Byte, Read/Write

## Figure 34. OPERATING MODE Register Format

7	6	5	4	3	2	1	0
P4M1	P4M0	P3M1	P3M0	P2M1	P2M0	P1M1	P1M0
R/W-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### **Table 14. OPERATING MODE Register Field Descriptions**

Bit	Field	Туре	Reset				Description			
-	P4M1-P4M0	R/W	0	Each pair	Each pair of bits configures the operating mode per port.					
	P3M1-P3M0			The select	tion is a	s following:				
	P2M1-P2M0			M1	МО	Operating Mode				
	P1M1–P1M0			0	0	OFF				
				0	1	Manual				
				1	0	Semiauto				
				1	1	Semiauto				
				there is no not the po Note that (CLSCn, I Status reg Power-on are also register w	o automa rt power while in DETCn) gister (C Fault re updated ill also b ange of	atic state change. In ser on.  n OFF mode, the core, Fault Event register CLASS Pn, DETECT Fegister (PFn). The corred accordingly. The core set if there is a chan mode from semiauto	is no detection nor classification. In Manual mode, emiauto mode, detection and class are automated but responding bits are cleared: Detection Event register (DISFn, ICUTn), Start Event register (STRTn), Port n Pn), Detect/Class Enable register (CLEn, DETEn) and esponding PEn and PGn bits of Power Status Register presponding PGCn and PECn bits of Power Event age.			

#### 8.6.16 DISCONNECT ENABLE Register

COMMAND = 13h with 1 Data Byte, Read/Write

Bit Descriptions: Defines the disconnect detection mechanism for each port.

## Figure 35. DISCONNECT ENABLE Register Format

7	6	5	4	3	2	1	0
_	-	_	_	DCDE4	DCDE3	DCDE2	DCDE1
R/W-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### **Table 15. DISCONNECT ENABLE Register Field Descriptions**

Bit	Field	Туре	Reset	Description
7–4	_	R/W	0	
3–0	DCDE4-DCDE1	R/W	0	DC disconnect enable. DC disconnect consists in measuring the port DC current at SENn, starting a timer (TDIS) if this current is below a threshold and turning the port off if a time-out occurs. Also, the corresponding disconnect bit (DISFn) in the FAULT EVENT register is set accordingly. The TDIS counter is reset each time the current goes continuously higher than the disconnect threshold for nominally 15 msec. The counter does not decrement below zero.
				Look at the TIMING CONFIGURATION register for more details on how to define the TDIS time period.

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#### 8.6.17 DETECT/CLASS ENABLE Register

COMMAND = 14h with 1 Data Byte, Read/Write

#### **Bit Descriptions:**

Detection and classification enable for each port.

When in Manual mode, setting a bit means that only one cycle (detection or classification) is performed for the corresponding port. The bit is automatically cleared by the time the cycle has been completed.

Note that similar result can be obtained by writing to the Detect/Class Restart register.

It is also cleared if a port turn off (Power Enable register) is issued.

When in semiauto mode, as long as the port is kept off, detection and classification are performed continuously, as long as the class and detect enable bits are kept set, but the class will be done only if the detection was valid. A Detect/Class Restart PB command can also be used to set the CLEn and DETEn bits, if in semiauto mode.

During  $t_{\text{OVLD}}$ ,  $t_{\text{LIM}}$  or  $t_{\text{START}}$  cool down cycle, any Detect/Class Enable command for that port will be delayed until end of cool-down period. Note that at the end of cool down cycle, one or more detection/class cycles are automatically restarted as described previously, if the class and/or detect enable bits are set.

#### Figure 36. DETECT/CLASS ENABLE Register Format

7	6	5	4	3	2	1	0
CLE4	CLE3	CLE2	CLE1	DETE4	DETE3	DETE2	DETE1
R/W-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### Table 16. DETECT/CLASS ENABLE Register Field Descriptions

	Bit	Field	Туре	Reset	Description
	7–4	CLE4-CLE1	R/W	0	Classification enable bits.
Ī	3–0	DETE4-DETE1	R/W	0	Detection enable bits.

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## 8.6.18 Port Power Priority/ICUT Disable Register Name

COMMAND = 15h with 1 Data Byte, R/W

## Figure 37. Port Power Priority/ICUT Disable Register Format

7	6	5	4	3	2	1	0
OSS4	OSS3	OSS2	OSS1	DCUT4	DCUT3	DCUT2	DCUT1
R/W-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## Table 17. Port Power Priority/ICUT Disable Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–4	OSS4-OSS1	R/W	0	Port power priority bits, one bit per port, if 1-bit shutdown priority has been selected. It is used to determine which port is shut down in response to an external assertion of the OSS fast shutdown signal. The turn off procedure (including register bits clearing) is similar to a port reset using Reset command (1Ah register), except that it does not cancel any ongoing fault cool down time count.
				1 = When the OSS signal is asserted, the corresponding port is powered off.
				0 = OSS signal has no impact on the port.
3–0	DCUT4-DCUT1	R/W	0	ICUT disable for each port. Used to prevent removal of the associated port's power due to an ICUT fault, regardless of the programming status of the Timing Configuration register. Note that there is still monitoring of ILIM faults.
				1: Port's ICUT is disabled. This means that an ICUT fault alone will not turn off this port.
				0: Port's ICUT is enabled. This enables port turn off if there is ICUT fault.
				Note that if ICUT is disabled for a port, this port will not be automatically turned off during an ICUT fault condition. However, the ICUT fault flag will still be operational, with a fault timeout equal to $t_{LIM}/2$ .

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#### 8.6.19 TIMING CONFIGURATION Register

COMMAND = 16h with 1 Data Byte, Read/Write

Bit Descriptions: These bits define the timing configuration for all four ports.

Note: the PGn and PEn bits (Power Status register) are cleared when there is a TLIM, TOVLD, TMPDO, or TSTART fault condition.

Figure 38. TIMING CONFIGURATION Register Format

7	6	5	4	3	2	1	0		
TLIM		TST	TSTART		TOVLD		TMPDO		
R/W-0 R/W-0		R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## **Table 18. TIMING CONFIGURATION Register Field Descriptions**

Bit	Field	Туре	Reset			Descri	•						
7 –6	TLIM	R/W	0	II INA fo	ult timina	which is the output current limit tir	•						
7-0	TLIIVI	R/VV	0	This tin window the pro	ner is active and whe ogrammed timer is the second contract to the second contract and the second cont	ve and increments to the settings on the port is limiting its output curlitime-out duration specified below	defined below after expiration of the TSTART time rent to I <sub>LIM</sub> . If the ILIM counter is allowed to reach to the port will be powered off. The 1-second cool not be turned-on until the counter has reached						
				same of below 2	In other circumstances (ILIM time-out has not been reached), while the port current is below $I_{LI}$ same counter decrements at a rate 1/16th of the increment rate. The counter does not decrebelow zero. The ILIM counter is also cleared in the event of a port turn off due to a Power Ena Port Reset command, a DC disconnect event or the OSS input.								
							d while this timer is already active for a port, this new programmed time-out duration.						
				Note that at the end of cool down cycle, when in semiauto mode, a detection cycle is automa restarted if the detect enable bit is set. Also note that the cool down time count is immed canceled with a port reset command, or if the OFF or Manual mode is selected.  When a PoFPn bit in PoF Plus register is deasserted, the time used for the associated port is a									
					When a PoEPn bit in PoE Plus register is deasserted, the t <sub>LIM</sub> used for the associated port is always the nominal value (about 60 ms).								
				If PoEF	PoEPn bit is asserted, then t <sub>LIM</sub> for associated port is programmable with the following selection:								
					TLIM	Nominal t <sub>LIM</sub> (ms)							
					0 0	60							
					0 1	15							
					1 0	12							
					1 1	10							
5-4	TSTART (or	R/W	0			ng, which is the maximum allowed he current is still limited to I <sub>Inrush</sub> , t	overcurrent time during inrush. If at the end of the port is powered off.						
	TINRUSH)						uring which the port can not be turned-on						
				restarte	ed if the cl	ass and detect enable bits are set							
						event the TSTART setting is cha s ignored and will be applied only	nged while this timer is already active for a port, next time the port is turned ON.						
				The selection is as following:									
				TSTART Nominal t <sub>START</sub> (ms)									
				0         0         60           0         1         30									
					1 0	120							
					1 1	Reserved							



# Table 18. TIMING CONFIGURATION Register Field Descriptions (continued)

Bit	Field	Туре	Reset				Descri	ption				
3–2	TOVLD	R/W	0	increr port c is allo The 1	ments currer owed -seco	s to the nt meet to read ond co	e settings defined below after expires or exceeds I <sub>CUT</sub> , or when it is ling that the programmed time-out durati	ation before port turn off. This timer is active and ration of the TSTART time window and when the nited by the current foldback. If the ICUT counter ion specified below, the port will be powered off. the port can not be turned-on until the counter				
				the s decre	ame ment	count below	er decrements at a rate 1/16th	en reached), while the port current is below $I_{\text{CUT}}$ , of the increment rate. The counter does not cleared in the event of a port turn off due to a innect event or the OSS input				
								ed while this timer is already active for a port, this new programmed time-out duration.				
				restar	ted i	f the c		semiauto mode, a detection cycle is automatically e that the cool down time count is immediately or Manual mode is selected.				
				timing	Note that if a DCUTn bit is high in the Port Power Priority/ICUT Disable register, the ICUT fault iming for the associated port is disabled. This means that this port will not be turned off if there is only ICUT fault.							
				The s	elect	ion is a	as following:					
					то	VLD	Nominal t <sub>OVLD</sub> (ms)					
					0	0	60					
					0	1	30					
					1	0	120					
					1	1	240					
1–0	TMPDO	R/W	0				, which is the time to turn off a portect method has been enabled.	rt once there is a disconnect condition, and if the				
							er is reset each time the curren ninally 15 ms.	t goes continuously higher than the disconnect				
				The c	ounte	er does	s not decrement below zero.					
				The s	The selection is as following:							
					TMPDO Nominal t <sub>MPDO</sub> (ms)							
					0	0	360					
					0	1	90					
					1	0	180					
					1	1	720					



## 8.6.20 GENERAL MASK Register

COMMAND = 17h with 1 Data Byte, Read/Write

## Figure 39. GENERAL MASK Register Format

7	6	5	4	3	2	1	0
INTEN	_	nbitACC	MbitPrty	CLCHE	DECHE	1	_
R/W-1	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## **Table 19. GENERAL MASK Register Field Descriptions**

Bit	Field	Туре	Reset	Description		
7	INTEN	R/W	1	$\overline{\text{INT}}$ pin mask bit. Writing a 0 will mask any bit of Interrupt register from activating the $\overline{\text{INT}}$ output, whatever the state of the Interrupt Mask register. Note that activating INTEN has no impact on the event registers.		
				1 = Any unmasked bit of Interrupt register can activate the INT output		
				0 = INT output cannot be activated		
6	_	R/W	0			
5	nbitACC	R/W	0	Register Access Configuration bit. Used to select configuration A or B.		
				1 = Configuration B. This means 16-bit access with a single device address.		
				0 = Configuration A. This means 8-bit access, while the 8-port device is treated as 2 separate 4-port devices with 2 consecutive slave addresses.		
4	MbitPrty	R/W	0	Multi Bit Priority bit. Used to select between 1-bit shutdown priority and 3-bit shutdown priority.		
				1 = 3-bit shutdown priority. Register 0x27 and 0x28 need to be followed for port priority and OSS action.		
			0 = 1-bit shutdown priority. Register 0x15 needs to be followed for po			
				Note: If the MbitPrty bit needs to be changed from 0 to 1, make sure the OSS input is in the idle (low) state for a minimum of 200 µsec prior to setting the MbitPrty bit, to avoid any port misbehavior related to loss of synchronization with the OSS bit stream.		
3	CLCHE	R/W	0	Class change Enable bit. When set, the CLSCn bits in Detection Event register only indicates when the result of the most current classification operation differs from the result of the previous one.		
				1 = CLSCn bit is set only when a change of class occurred for the associated port.		
				0 = CLSCn bit is set each time a classification cycle occurred for the associated port.		
2	DECHE	R/W	0	Detect Change Enable bit. When set, the DETCn bits in Detection Event register only indicates when the result of the most current detection operation differs from the result of the previous one.		
				1 = DETCn bit is set only when a change in detection occurred for the associated port.		
				0 = DETCn bit is set each time a detection cycle occurred for the associated port.		
1	_	R/W	0			
0	-	R/W	0			



#### 8.6.21 DETECT/CLASS RESTART Register

COMMAND = 18h with 1 Data Byte, Write Only

Push button register.

Each bit corresponds to a particular cycle (detect or class restart) per port. Each cycle can be individually triggered by writing a 1 at that bit location, while writing a 0 does not change anything for that event.

In Manual mode, a single cycle (detect or class restart) will be triggered while in Semiauto mode, it sets the corresponding bit in the Detect/Class Enable register.

A Read operation will return 00h.

During  $t_{\text{OVLD}}$ ,  $t_{\text{LIM}}$  or  $t_{\text{START}}$  cool down cycle, any Detect/Class Restart command for that port will be accepted but the corresponding action will be delayed until end of cool-down period.

Figure 40. DETECT/CLASS RESTART Register Format

7	6	5	4	3	2	1	0
RCL4	RCL3	RCL2	RCL1	RDET4	RDET3	RDET2	RDET1
W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0

LEGEND: R/W = Read/Write; R = Read only; W = Write only; -n = value after reset

#### Table 20. DETECT/CLASS RESTART Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–4	RCL4-RCL1	W	0	Restart classification bit
3–0	RDET4-RDET1	W	0	Restart detection bits



#### 8.6.22 POWER ENABLE Register

COMMAND = 19h with 1 Data Byte, Write Only

Push button register.

Used to force a port(s) turn on or turn off in any mode except OFF mode. If TPON bit in the PoE Plus register is low, or if the PSE controller is configured in Manual mode, writing a 1 at that PWONn bit location will immediately turn on the associated port, regardless of the classification and detection status and regardless of the IEEE802.3 TPON timing specification. This is also the case if TPON is set and DETn bit is 0, in semiauto mode.

If TPON bit in the PoE Plus register is set, and DETn bit (DETECT/CLASS ENABLE register) is set and while in semiauto mode, writing a 1 at a PWONn bit will turn on the associated port but only if the IEEE802.3 TPON timing specification can be met and if the detection is valid (and class is valid if enabled). TPON specification is the time from the completion of a valid detection cycle to port turn ON.

If TPON specification cannot be met, a new detection cycle is restarted, followed by a classification cycle if enabled, at the end of which the port is turned on, but only if a valid detection is returned and the IEEE802.3 TPON specification can be met. For this case, there is no additional attempt to turn on the port until this push button is reasserted. If the last detection result is not valid, the port is not turned on.

Note that in semiauto, as long as the port is kept off, detection and classification are performed continuously, if the corresponding class and detect enable bits are set.

Writing a 1 at POFFn location turns off the associated port.

Note that writing a 1 at POFFn and PWONn of same port during the same write operation turns the port off.

Also note that  $t_{\text{OVLD}}$ ,  $t_{\text{LIM}}$ ,  $t_{\text{START}}$ , and disconnect events have priority over the power on command. During  $t_{\text{OVLD}}$ ,  $t_{\text{LIM}}$ , or  $t_{\text{START}}$  cool down cycle, any port turn on using Power Enable command will be ignored and the port will be kept off.

Turning OFF a port with this command also clears the corresponding bits in Detection Event register (CLSCn, DETCn), Fault Event register (DISFn, ICUTn), Start Event register (STRTn, ILIMn), Port n Status register (CLASS Pn, DETECT Pn), DETECT/CLASS ENABLE register (CLEn, DETEn) and Power-on Fault register (PFn). The corresponding PGCn and PECn bits of Power Event register will also be set if there is a change. The corresponding PEn and PGn bits of Power Status Register are also updated accordingly.

Figure 41. POWER ENABLE Register Format

7	6	5	4	3	2	1	0
POFF4	POFF3	POFF2	POFF1	PWON4	PWON3	PWON2	PWON1
W-0							

LEGEND: R/W = Read/Write; R = Read only; W = Write only; -n = value after reset

#### Table 21. POWER ENABLE Register Field Descriptions

	Bit	Field	Туре	Reset	Description
	7–4	POFF4-POFF1	W	0	Port power off bits
Ī	3–0	PWON4-PWON1	W	0	Port power on bits

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#### 8.6.23 RESET Register

COMMAND = 1Ah with 1 Data Byte, Write Only

Push button register.

Writing a 1 at a bit location triggers an event while a 0 has no impact. Self-clearing bits.

## Figure 42. RESET Register Format

Ī	7	6	5	4	3	2	1	0
	CLRAIN	CLINP	_	RESAL	RESP4	RESP3	RESP2	RESP1
	W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0

LEGEND: R/W = Read/Write; R = Read only; W = Write only; -n = value after reset

## **Table 22. RESET Register Field Descriptions**

Bit	Field	Туре	Reset	Description
7	CLRAIN	W	0	Clear all interrupts bit. Writing a 1 to CLRAIN clears all event registers and all bits in the Interrupt register. It also releases the INT pin
6	CLINP	W	0	When set, it releases the $\overline{\text{INT}}$ pin without any impact on the Event registers nor on the Interrupt register.
5	_	W	0	
4	RESAL	W	0	Reset all bits when RESAL is set. Results in a state equivalent to a power-up reset. Note that the VDUV and VPUV bits (Supply Event register) follow the state of VDD and VPWR supply rails.
3–0	RESP4-RESP1			Reset port bits. Used to force an immediate port(s) turn off in any mode, by writing a 1 at the corresponding RESPn bit location(s).
				Turning OFF a port with this command also clears the corresponding bits in Detection Event register (CLSCn, DETCn), Fault Event register (DISFn, ICUTn), Start Event register (STRTn, ILIMn), Port n Status register (CLASS Pn, DETECT Pn), DETECT/CLASS ENABLE register (CLEn, DETEn) and Power-on Fault register (PFn). Note that the port can be turned back on immediately after a port reset; this means that any ongoing cool down cycle becomes immediately terminated once a port reset is received.
				The corresponding PGCn and PECn bits of Power Event register will also be set if there is a change. The corresponding PEn and PGn bits of Power Status Register are also updated accordingly.

#### 8.6.24 ID Register

COMMAND = 1Bh with 1 Data Byte, Read/Write

## Figure 43. ID Register Format

7	6	5	4	3	2	1	0
		MFR ID	ICV				
R/W-0	R/W-0 R/W-1 R/W-0			R/W-0	R/W-0	R/W-1	R/W-1

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### **Table 23. ID Register Field Descriptions**

Bit	Field	Туре	Reset	Description
7–3	MFR ID	R/W	01010 b	Manufacture Identification number (0101,0)
2–0	ICV	R/W	011b	IC version number (011)

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## 8.6.25 Police 21 Configuration Register

COMMAND = 1Eh with 1 Data Byte, Read/Write

Replaces the ICUT mechanism. The threshold is defined with the Police bits and the PoE Plus register.

Figure 44. Police 21 Register Format

7	6	5	4	3	2	1	0
POL2_3	POL2_2	POL2_1	POL2_0	POL1_3	POL1_2	POL1_1	POL1_0
R/W-1	R/W1						

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 8.6.26 Police 43 Configuration Register

COMMAND = 1Fh with 1 Data Byte, Read/Write

Replaces the ICUT mechanism. The threshold is defined with the Police bits and the PoE Plus register.

#### Figure 45. Police 43 Register Format

7	6	5	4	3	2	1	0
POL4_3	POL4_2	POL4_1	POL4_0	POL3_3	POL3_2	POL3_1	POL3_0
R/W-1	R/W1						

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### Table 24. Police 43 Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–0	POLn_3-	R/W	1	4-bit nibble defining I <sub>CUT</sub> threshold. The result varies depending on the PoE Plus port bit.
	POLn_0			The equation defining the I <sub>CUT</sub> threshold is:
				$I_{CUT} = (N \times IC_{STEP}) + IC_{OFFS}$
				Where, when assuming 0.255- $\Omega$ Rsense resistor is used:
				IC <sub>STEP</sub> = 20 mA (1 W resolution if at 50 V) when the associated port's PoE Plus bit is 0
				IC <sub>STEP</sub> = 40 mA (2 W resolution if at 50 V)when the associated port's PoE Plus bit is 1
				and:
				IC <sub>OFFS</sub> = 20 mA when the associated port's PoE Plus bit is 0
				IC <sub>OFFS</sub> = 320 mA (16 W if at 50 V) when the associated port's PoE Plus bit is 1
				Note:
				When a PoEPn bit is set in PoE Plus register, the corresponding POLn bits are initially changed to 0x0.
				When a PoEPn bit is reset in PoE Plus register, the corresponding POLn bits are initially changed to 0xF.
				In both cases, the port police current threshold is the same value.

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#### 8.6.27 IEEE Power Enable Register

COMMAND = 23h with 1 Data Byte, Write Only

Used to do a port(s) turn on during semiauto mode. This command is ignored if in manual mode. Note that if at completion of this command the addressed port is not turned on, the corresponding bits in the Detect/Class Enable register (register 14h) are being set, which means that detection and classification are performed continuously, as long as the class and detect enable bits are kept set.

Writing a 1 at a TmPONn bit will turn on the associated port but only if the IEEE802.3 TPON timing specification can be met. TPON specification is the time from the completion of a valid detection cycle to port turn ON.

If TPON specification cannot be met, a new detection cycle is restarted, followed by a classification cycle, at the end of which the port is turned on, but only if a valid detection and classification is returned. For this case, there is no additional attempt to turn on the port until this push button is reasserted.

Note that a port turn on will be performed only after both its current detection and classification cycle are completed

Note that writing a 1 at T1PONn and T2PONn of same port during the same write operation is interpreted as a T1PONn.

The corresponding PGCn and PECn bits of Power Event register will also be set depending on the result, while the CLSCn and DETCn bits of Detection Event register will be set based on the result and the CLCHE and DECHE bits in the General Mask register.

Also note that  $t_{\text{OVLD}}$ ,  $t_{\text{LIM}}$ ,  $t_{\text{START}}$ , and disconnect events are prioritary over the power on command. During  $t_{\text{OVLD}}$ ,  $t_{\text{LIM}}$ , or  $t_{\text{START}}$  cool down cycle, any port turn on using IEEE Power Enable command will be ignored and the port will be kept off.

Figure 46. IEEE Power Enable Register Format

7	6	5	4	3	2	1	0	
T	ype 2 IEEE Power	Enable Pushbutte	on	Type 1 IEEE Power Enable Pushbutton				
T2PON4	T2PON4 T2PON3		T2PON1	T1PON4	T1PON3	T1PON2	T1PON1	
W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0	

LEGEND: R/W = Read/Write; R = Read only; W = Write only; -n = value after reset

#### Table 25. IEEE Power Enable Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–4	T2PON4–T2PON1	W	0	If class 4 is detected during the first event classification, a second event classification is performed. If the last detection result is not valid or last classification result yields "over current" or is different from the first classification event result, the port is not turned on, and the STRTn bit in Start/Ilim Event register is set, while the corresponding fault code in the Power-on Fault register is written.
				When power-on is complete and if class 4 has been detected, the corresponding PoEPn bit in PoE Plus register is set and the value of the corresponding Police Configuration register is set to 640 mA (08h code). This is done within 5 ms of completion of inrush.
3–0	T1PON4-T1PON1	W	0	Indicates only a single-event classification is performed, even if a class 4 PD is detected.
				If the last detection result is not valid or last classification result yields "over current", the port is not turned on, and the STRTn bit in Start/Ilim Event register is set, while the corresponding fault code in the Power-on Fault register is written.



## 8.6.28 Power-on Fault Register

COMMAND = 24h with 1 Data Byte, Read Only

COMMAND = 25h with 1 Data Byte, Clear on Read

Figure 47. Power-on Fault Register Format

7	6	5	4	3	2	1	0
P	PF4		F3	P	PF2		F1
R-0							
CR-0							

LEGEND: R/W = Read/Write; R = Read only; W = Write only; CR = Clear on Read; -n = value after reset

## Table 26. Power-on Fault Register Field Descriptions

Bit	Field	Туре	Reset		Description							
7–0	PF4-PF1	R or CR	0	Enabl	e comm	nand. Th	status of the classification and detection and detection is the state of the state	ction for port n, following an IEEE Power turned off.				
					Fault Code Power-on Fault Description							
					0	0	No fault					
					0	1	Invalid detection					
					1 0 Classification overcurrent							
					1 1 Classification mismatch							



## 8.6.29 PORT RE-MAPPING Register

COMMAND = 26h with 1 Data Byte, Read/Write

## Figure 48. PORT RE-MAPPING Register Format

7	6	5 4		3	2	1	0
Physical Port # of Logical Port 4		Physical Port #	of Logical Port 3	Physical Port #	of Logical Port 2	Physical Port #	of Logical Port 1
R/W-1	R/W-1 R/W-1 R/W-1		R/W-0	R/W-0	R/W-1	R/W-0	R/W-0

LEGEND: R/W = Read/Write; R = Read only; W = Write only; CR = Clear on Read; -n = value after reset

## Table 27. PORT RE-MAPPING Register Field Descriptions

Bit	Field	Type	Reset					Description							
7–0	Physical Port # of Logical Port n	R/W	1/0	of a 4-port remappir	port g -mapp ng. pair of	roup (1 ping co bits co	-4, 5-8). All ports mmand, otherwis	o physical board constraints. Re- of a group of four must be in Ol e the command will be ignored. logical port assigned.	FF mode prior to receiving the						
					Re-N		Physical Port	Package Pins							
					0 0 1 Drain1,Gat1,Sen1										
					0 1 2 Drain2,Gat2,Sen2										
					1 0 3 Drain3,Gat3,Sen3										
					1	1	4	Drain4,Gat4,Sen4							
				value 1 logical Note: 0	11 ind port 3 Code more	icate th 3 is ma duplica than o	nat logical port 4 in opped onto physical ation is not allowe one port – if such a	fault value of this register is 111 s mapped onto physical port 4, t al port 3 and so on. ed – that is, Same code cannot a value is received, it will be ign	the next 2 bits, 10, suggest be written into the remapping						
				`	•	·		s kept unchanged if 0x1A IC res	set command is received.						
					NOTE  After port remapping, TI recommends to do at least one detection-classification cycle before next port turn on.										

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## 8.6.30 Port 21 Multi Bit Priority Register

COMMAND = 27h with 1 Data Byte, Read/Write.

## Figure 49. Port 21 Register Format

7	6	5	4	3	2	1	0
_	MBP2_2	MBP2_1	MBP2_0	1	MBP1_2	MBP1_1	MBP1_0
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 8.6.31 Port 43 Multi Bit Priority Register

COMMAND = 28h with 1 Data Byte, Read/Write

## Figure 50. Port 43 Register Format

7	6	5	4	3	2	1	0
_	MBP4_2	MBP4_1	MBP4_0	_	MBP3_2	MBP3_1	MBP3_0
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## Table 28. Port 43 Register Field Descriptions

Bit	Field	Туре	Reset	Descrip	Description							
7–0	MBPn_2-0	R/W	0	selected down in	d (MbitF n respor	Prty in Ger	neral Mas erial shut	sk register is high). I down code received	s per port, if 3-bit shutdown priority has been t is used to determine which port(s) is (are) shut at the OSS shutdown input. A port with 000 3-bit value increases.			
					ne turn off procedure (including register bits clearing) is similar to a port reset using Reset command Ah register), except that it does not cancel any ongoing fault cool down time count.							
				The por	e port priority is defined as followings:							
				05	OSS code ≤ MBPn_2-0 : when the OSS code is received, the corresponding port is powered off.							
				OS	OSS code > MBPn_2-0 : OSS code has no impact on the port							
					MBP	n_2-0 0x2 Register		Multi Bit Priority	Condition for Port Off			
					0	0	0	Highest	OSS = '000'			
					0	0	1	2	OSS = '000' or '001'			
					0	1	0	3	OSS ≤ '010'			
					0 1 1 4 OSS ≤ '011'							
					1 0 0 5 OSS ≤ '100'							
					1 0 1 6 OSS = any code except '111'							
					1	1	1	Lowest	OSS = any code			

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## 8.6.32 TEMPERATURE Register

COMMAND = 2Ch with 1 Data Byte, Read Only

## Figure 51. TEMPERATURE Register Format

7	6	5	4	3	2	1	0
TEMP7	TEMP6	TEMP5	TEMP4	TEMP3	TEMP2	TEMP1	TEMP0
R-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## **Table 29. TEMPERATURE Register Field Descriptions**

Field	Type	Reset	Description							
TEMP7-TEMP0	R	0	Bit Description	Bit Descriptions: Data conversion result. The I <sup>2</sup> C data transmission is a 1-byte transfer.						
			8-bit Data conversion result of temperature, from $-20^{\circ}\text{C}$ to 125°C. The update rate is around once per second.							
			The equation defining the temperature measured is:							
			T = -20	+ N × T <sub>STEP</sub>						
			Where T <sub>STEP</sub>	is defined below as well	as the full scale value:					
			Mode Full Scale Value T <sub>STEP</sub>							
			Any 146.2°C 0.652°C							
7	EMP7-TEMP0	TEMP7-TEMP0 R	TEMP7-TEMP0 R 0	8-bit Data co around once The equation $T = -20$ Where $T_{STEP}$	8-bit Data conversion result of temparound once per second.  The equation defining the temperatur $T = -20 + N \times T_{STEP}$ Where $T_{STEP}$ is defined below as well  Mode Full Scale Value	8-bit Data conversion result of temperature, from $-20^{\circ}\text{C}$ to around once per second.  The equation defining the temperature measured is: $T = -20 + \text{N} \times \text{T}_{\text{STEP}}$ Where $\text{T}_{\text{STEP}}$ is defined below as well as the full scale value:				

#### 8.6.33 INPUT VOLTAGE Register

COMMAND = 2Eh with 2 Data Byte (LSByte first, MSByte second), Read only

## Figure 52. INPUT VOLTAGE Register Format

7	6	5	4	3	2	1	0
LSB:							
VPWR7	VPWR6	VPWR5	VPWR4	VPWR3	VPWR2	VPWR1	VPWR0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
MSB:							
_	_	VPWR13	VPWR12	VPWR11	VPWR10	VPWR9	VPWR8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

 $\label{eq:legender} \mbox{LEGEND: R/W = Read/Write; R = Read only; -n = value after reset}$ 

## **Table 30. INPUT VOLTAGE Register Field Descriptions**

Bit	Field	Туре	Reset		Description								
13–0	VPWR13- VPWR0	R	0	Bit Descriptions: Data conversion result. The I <sup>2</sup> C data transmission is a 2-byte transfer.									
				14-bit Data c	14-bit Data conversion result of input voltage.								
				The equation	The equation defining the voltage measured is:								
				V = N ×	$V = N \times V_{STEP}$								
				Where V <sub>STEP</sub>	is defined below as	well as the full sca	ale value:						
				Mode	Full Scale Value	V <sub>STEP</sub>							
				Any 60 V 3.662 mV									
				Note that the	measurement is ma	de between VPWF	R and AGND.						

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## 8.6.34 PORT 1 CURRENT Register

COMMAND = 30h with 2 Data Byte, (LSByte First, MSByte second), Read Only

Figure 53. PORT 1 CURRENT Register Format

7	6	5	4	3	2	1	0
LSB:							
l1_7	I1_6	I1_5	I1_4	I1_3	l1_2	l1_1	I1_0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
MSB:							
_	_	I1_13	l1_12	l1_11	l1_10	I1_9	I1_8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### 8.6.35 PORT 2 CURRENT Register

COMMAND = 34h with 2 Data Byte, (LSByte First, MSByte second), Read Only

Figure 54. PORT 2 CURRENT Register Format

7	6	5	4	3	2	1	0
LSB:							
12_7	I2_6	I2_5	12_4	I2_3	12_2	I2_1	I2_0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
MSB:							
_	_	I2_13	I2_12	I2_11	I2_10	I2_9	I2_8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 8.6.36 PORT 3 CURRENT Register

COMMAND = 38h with 2 Data Byte, (LSByte First, MSByte second), Read Only

Figure 55. PORT 3 CURRENT Register Format

7	6	5	4	3	2	1	0
LSB:							
13_7	I3_6	I3_5	13_4	I3_3	13_2	I3_1	I3_0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
MSB:							
_	_	I3_13	I3_12	I3_11	I3_10	13_9	I3_8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### 8.6.37 PORT 4 CURRENT Register

COMMAND = 3Ch with 2 Data Byte, (LSByte First, MSByte second), Read Only

Figure 56. PORT 4 CURRENT Register Format

7	6	5	4	3	2	1	0
LSB:							
14_7	I4_6	I4_5	I4_4	14_3	I4_2	I4_1	I4_0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
MSB:							
_	_	I4_13	I4_12	l4_11	I4_10	I4 <b>_</b> 9	I4_8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset



# Table 31. PORT 4 CURRENT Register Field Descriptions

Bit	Field	Туре	Reset		Description					
13-0	In_13- In_0	R	0	Bit Descriptions: Data convers	ion result. The I <sup>2</sup> C data to	ransmission is a	2-byte transfer.			
				Note that the conversion is do	Note that the conversion is done using a TI proprietary multi-slope integrating converter.					
				14-bit Data conversion result of port powered state.	4-bit Data conversion result of current for port n. The update rate is around once per 100 ms in ort powered state.					
				The equation defining the curr	he equation defining the current measured is:					
				I = N × I <sub>STEP</sub>						
				Where I <sub>STEP</sub> is defined below a	Where I <sub>STEP</sub> is defined below as well as the full scale value, according to the operating mode:					
				Mode	Full Scale Value	I <sub>STEP</sub>				
				Port Powered and Classification	1 A (with 0.255 Ω Rsense)	61.035 μA				
				Note: in any of the following ca	Note: in any of the following cases, the result through I <sup>2</sup> C interface is automatically 0000					
				port is OFF while in semi	outo made and detect/ala	an in not anable	4			
				'						
				port is OFF while in semi	auto mode and detection	result is incorrec	रा			
				In manual mode, if detect/clast the last measurement	s has been enabled at le	east once, the reg	gister retains the result of			



## 8.6.38 PORT 1 VOLTAGE Register

COMMAND = 32h with 2 Data Byte, (LSByte First, MSByte second), Read Only

Figure 57. PORT 1 VOLTAGE Register Format

7	6	5	4	3	2	1	0
LSB:							
V1_7	V1_6	V1_5	V1_4	V1_3	V1_2	V1_1	V1_0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
MSB:							
_	_	V1_13	V1_12	V1_11	V1_10	V1_9	V1_8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### 8.6.39 PORT 2 VOLTAGE Register

COMMAND = 36h with 2 Data Byte, (LSByte First, MSByte second), Read Only

Figure 58. PORT 2 VOLTAGE Register Format

7	6	5	4	3	2	1	0
LSB:							
V2_7	V2_6	V2_5	V2_4	V2_3	V2_2	V2_1	V2_0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
MSB:							
_	_	V2_13	V2_12	V2_11	V2_10	V2_9	V2_8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 8.6.40 PORT 3 VOLTAGE Register

COMMAND = 3Ah with 2 Data Byte, (LSByte First, MSByte second), Read Only

Figure 59. PORT 3 VOLTAGE Register Format

7	6	5	4	3	2	1	0
LSB:							
V3_7	V3_6	V3_5	V3_4	V3_3	V3_2	V3_1	V3_0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
MSB:							
_	_	V3_13	V3_12	V3_11	V3_10	V3_9	V3_8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### 8.6.41 PORT 4 VOLTAGE Register

COMMAND = 3Eh with 2 Data Byte, (LSByte First, MSByte second), Read Only

Figure 60. PORT 4 VOLTAGE Register Format

7	6	5	4	3	2	1	0
LSB:							
V4_7	V4_6	V4_5	V4_4	V4_3	V4_2	V4_1	V4_0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
MSB:							
_	_	V4_13	V4_12	V4_11	V4_10	V4_9	V4_8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset



## Table 32. PORT 4 VOLTAGE Register Field Descriptions

Bit	Field	Туре	Reset		Desc	ription				
13-0	Vn_13- Vn_0	R	0	Bit Descriptions: Data	conversion result. The	I <sup>2</sup> C data transmiss	sion is a 2-byte transfer.			
				The equation defining	the voltage measured i	s:				
				$V = N \times V_{STEP}$	$V = N \times V_{STEP}$					
				Where V <sub>STEP</sub> is define	here V <sub>STEP</sub> is defined below as well as the full scale value:					
				Mode	Full Scale Value	V <sub>STEP</sub>				
				Port Powered	60 V	3.662 mV				
					ote that a powered port voltage measurement is made between VPWR and DRAINn. lote: if a port is OFF, the result through I <sup>2</sup> C interface is automatically 0000.					

## 8.6.42 PoE Plus Register

COMMAND = 40h with1 Data Byte Read/Write

## Figure 61. PoE Plus Register Format

7	6	5	4	3	2	1	0
PoEP4	PoEP3	PoEP2	PoEP1	_	_	_	TPON
R/W-0	R/W-0	R/W-0	R/W-0	_	_	_	R/W-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## Table 33. PoE Plus Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–4	PoEP4- PoEP1	R/W	0	When set, this activates the PoE Plus mode for a port which increases its $I_{LIM}$ and $I_{SHORT}$ levels to around 2 ½ times their normal settings, as shown in Figure 18. Also the PoE Plus bit is used with the Police Configuration register to define $I_{CUT}$ threshold. See Police Configuration register for more details on the subject. Note that the fault timer starts when the $I_{LIM}$ or $I_{CUT}$ (if ICUT is enabled) threshold is exceeded. Also see the Port Power Priority/ICUT Disable register.
				Notes:
				At port turn on, the inrush current profile remains the same, whatever the state of the PoEPn bit, as shown in Figure 17.
				2) When a PoEPn bit is set, the corresponding POLn bits in Police Configuration register are initially changed to 0x0. When a PoEPn bit is reset, the corresponding POLn bits in Police Configuration register are initially changed to 0xF. In both cases, the port police current threshold is the same value.
				3) When a PoEPn bit is deasserted, the t <sub>LIM</sub> used for the associated port is always the nominal value (~60 ms). If PoEPn bit is asserted, then t <sub>LIM</sub> for associated port is programmable as defined in the Timing Configuration register.
				4) If a port is turned on by use of the Type 2 IEEE Power Enable Pushbutton, the PSE does the following. When power-on is complete and if class 4 has been detected, the corresponding PoEPn bit is set and the value of the corresponding Police Configuration register is set to 640 mA (08h code). This is done within 5 ms of completion of inrush.
0	TPON	R/W	0	When set, if DETn bit (DETECT/CLASS ENABLE register) is set and while in semiauto mode, writing a 1 at a PWONn bit in the Power Enable register will turn on a port after the current detection (and class is valid if enabled) cycle is completed but only if the IEEE802.3 TPON timing specification can be met. TPON specification is the time from the completion of a valid detection cycle to port turn ON.
				If TPON specification cannot be met, a new detection cycle is restarted, followed by a classification cycle, at the end of which the port is turned on, but only if a valid detection is returned. For this case, there is no additional attempt to turn on the port until this push button is reasserted.
				If TPON bit is low, writing a 1 at a PWONn bit in the Power Enable register will turn on the associated port immediately, regardless of IEEE802.3 TPON timing specification and regardless of the detection result.

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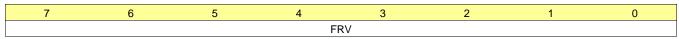
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#### 8.6.43 FIRMWARE REVISION

COMMAND = 41h with 1 Data Byte, Read Only

## Figure 62. FIRMWARE REVISION Register Format



LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### **Table 34. FIRMWARE REVISION Register Field Descriptions**

Bit	Field	Туре	Reset	Description
7–0	FRV	R		Firmware Revision number

#### 8.6.44 I2C WATCHDOG Register

COMMAND = 42h with 1 Data Byte, Read/Write

The I<sup>2</sup>C watchdog timer monitors the I<sup>2</sup>C clock line in order to prevent hung software situations that could leave ports in a hazardous state. The timer can be reset by either edge on SCL input. If the watchdog timer expires, all ports will be turned off and WDS bit will be set. The nominal watchdog time-out period is 2 seconds.

## Figure 63. I2C WATCHDOG Register Format

7	6	5	4	3	2	1	0
_	_	_	IWDD3	IWDD2	IWDD1	IWDD0	WDS
_	_	_	R/W-1	R/W-0	R/W-1	R/W-1	R/W-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### Table 35. I2C WATCHDOG Register Field Descriptions

Bit	Field	Туре	Reset	Description
4–1	IWDD3-IWDD0	R/W	1011b	$\rm I^2C$ Watchdog disable. When equal to 1011b, the watchdog is masked. Otherwise, it is umasked and the watchdog is operational.
0	WDS	R/W	0	I <sup>2</sup> C Watchdog timer status, valid even if the watchdog is masked. When set, it means that the watchdog timer has expired without any activity on I <sup>2</sup> C clock line. Writing 0 at WDS location clears it. Note that when the watchdog timer expires and if the watchdog is unmasked, all ports are also turned off.

When the ports are turned OFF due to I<sup>2</sup>C watchdog, the corresponding bits in Detection Event register (CLSCn, DETCn), Fault Event register (DISFn, ICUTn), Start Event register (STRTn, ILIMn), Port n Status register (CLASS Pn, DETECT Pn), DETECT/CLASS ENABLE register (CLEn, DETEn) and Power-on Fault register (PFn) are also cleared.

The corresponding PGCn and PECn bits of Power Event register will also be set if there is a change. The corresponding PEn and PGn bits of Power Status Register are also updated accordingly.

#### NOTE

If the I<sup>2</sup>C watchdog timer has expired, the Temperature and Input voltage registers will stop being updated until the WDS bit is cleared. The WDS bit must then be cleared to allow these registers to work normally.

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## 8.6.45 DEVICE ID Register

COMMAND = 43h with 1 Data Byte, Read Only

## Figure 64. DEVICE ID Register Format

7	6	5	4	3	2	1	0
	DID				SR		

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

#### Table 36. DEVICE ID Register Field Descriptions

Bit	Field	Туре	Reset	Description
7–5	DID	R	110b	Device ID number (110)
4–0	SR	R		Silicon Revision number

## 8.6.46 PORT 1 DETECT RESISTANCE Register

COMMAND = 44h with 1 Data Byte, Read Only

#### Figure 65. PORT 1 DETECT RESISTANCE Register Format

7	6	5	4	3	2	1	0
R1_7	R1_6	R1_5	R1_4	R1_3	R1_2	R1_1	R1_0
R-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 8.6.47 PORT 2 DETECT RESISTANCE Register

COMMAND = 45h with 1 Data Byte, Read Only

#### Figure 66. PORT 2 DETECT RESISTANCE Register Format

7	6	5	4	3	2	1	0
R2_7	R2_6	R2_5	R2_4	R2_3	R2_2	R2_1	R2_0
R-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 8.6.48 PORT 3 DETECT RESISTANCE Register

COMMAND = 46h with 1 Data Byte, Read Only

#### Figure 67. PORT 3 DETECT RESISTANCE Register Format

7	6	5	4	3	2	1	0
R3_7	R3_6	R3_5	R3_4	R3_3	R3_2	R3_1	R3_0
R-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

## 8.6.49 PORT 4 DETECT RESISTANCE Register

COMMAND = 47h with 1 Data Byte, Read Only

#### Figure 68. PORT 4 DETECT RESISTANCE Register Format

7	6	5	4	3	2	1	0
R4_7	R4_6	R4_5	R4_4	R4_3	R4_2	R4_1	R4_0
R-0							

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

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## Table 37. PORT 4 DETECT RESISTANCE Register Field Descriptions

Bit	Field	Туре	Reset	Description							
7-0	Rn_7- Rn_0	R	0	8-bit data conversion result of detection resistance for port n.							
				Most recent 2-point Detection Resistance measurement result. The I <sup>2</sup> C data transmission is a 1-byte transfer.							
				Note that the register content is not cleared at port turn off.							
				The equation defining the resistance measured is:							
				$R = N \times R_{STEP}$	$R = N \times R_{STEP}$						
				Where R <sub>STEP</sub> is defined below as well as the full scale value:							
				Useable Resistance Range R <sub>STEP</sub>							
				$2~\text{k}\Omega$ to $50~\text{k}\Omega$	195.3125 $\Omega$						



## 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 9.1 Application Information

#### 9.1.1 Introduction to PoE

Power-over-Ethernet (PoE) is a means of distributing power to Ethernet devices over the Ethernet cable using either data or spare pairs. PoE eliminates the need for power supplies at the Ethernet device. Common applications of PoE are security cameras, IP Phones and PDA chargers. The host or mid-span equipment that supplies power is the power source equipment (PSE). The load at the Ethernet connector is the powered device (PD). PoE protocol between PSE and PD controlling power to the load is specified by IEEE Std 802.3at-2009. Transformers are used at Ethernet host ports, mid-spans and hubs, to interface data to the cable. A DC voltage can be applied to the center tap of the transformer with no effect on the data signals. As in any power transmission line, a relatively high 48 V is used to keep current low, minimize the effect of IR drops in the line and preserve power to the load. Standard POE delivers approximately 13 W to a type 1 PD, and 25.5 W to a type 2 PD.

#### 9.1.2 TPS2388 Application

The TPS2388 is an 8-port, IEEE 802.3at PoE PSE controller and can be used in high port count semiauto or fully micro-controller managed applications (The MSP430G2553 micro-controller is recommended for most applications). Subsequent sections describe detailed design procedures for applications with different requirements including host control.

The schematic of Figure 71 depicts semiauto mode operation of the TPS2388, providing functionality to power PoE loads. In Figure 71 the TPS2388 can do the following:

- 1. Performs load detection.
- 2. Performs classification including type-2 (two-finger) of up to Class 4 loads.
- 3. Enables power with protective foldback current limiting, and POLICE (I<sub>CUT</sub>) value.
- 4. Shuts down in the event of fault loads and shorts.
- 5. Performs Maintain Power Signature function to insure removal of power if load is disconnected.
- 6. Undervoltage lock out occurs if VPWR falls below VPUV\_F (typical 26.5 V).

Following a power-off command, disconnect or shutdown due to a start, ICUT or ILIM fault, the port powers down. Following port power off due to a power off command or disconnect, the TPS2388 will restart a detection cycle if commanded to do so through I<sup>2</sup>C bus. If the shutdown is due to a start, ICUT or ILIM fault, the TPS2388 enters into a cool-down period during which any Detect/Class Enable Command for that port will be delayed. At the end of cool down cycle, one or more detection/class cycles are automatically restarted if the class and/or detect enable bits are set.

#### 9.1.3 Kelvin Current Sensing Resistor

Load current in each PSE port is sensed as the voltage across a low-end current-sense resistor with a value of 255 m $\Omega$ . For more accurate current sensing, kelvin sensing of the low end of the current-sense resistor is provided through pins KSENSA for ports 1 and 2, KSENSB for ports 3 and 4, KSENSC for ports 5 and 6 and KSENSD for ports 7 and 8.



## **Application Information (continued)**

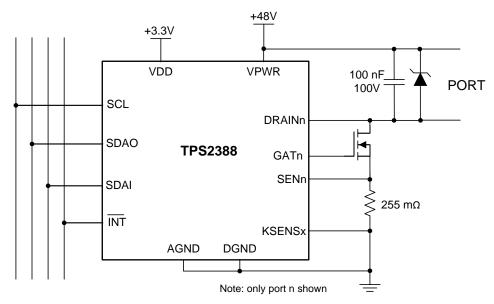


Figure 69. Kelvin Current-Sense Connection

#### 9.1.4 Connections on Unused Ports

On unused ports, it is recommended to ground the SENx pin and leave the GATx pin open. DRAINx pins can be grounded or left open (leaving open may slightly reduce power consumption). Figure 70 shows an example of an unused PORT4.

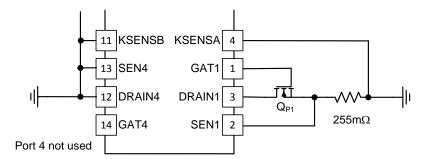


Figure 70. Unused PORT4 Connections



## 9.2 Typical Application

This typical application shows an eight port, semiauto mode application using MSP430 microcontroller. Operation in any mode requires I<sup>2</sup>C host support. The TPS2388 provides useful telemetry in multi-port applications to aid in implementing port power management.

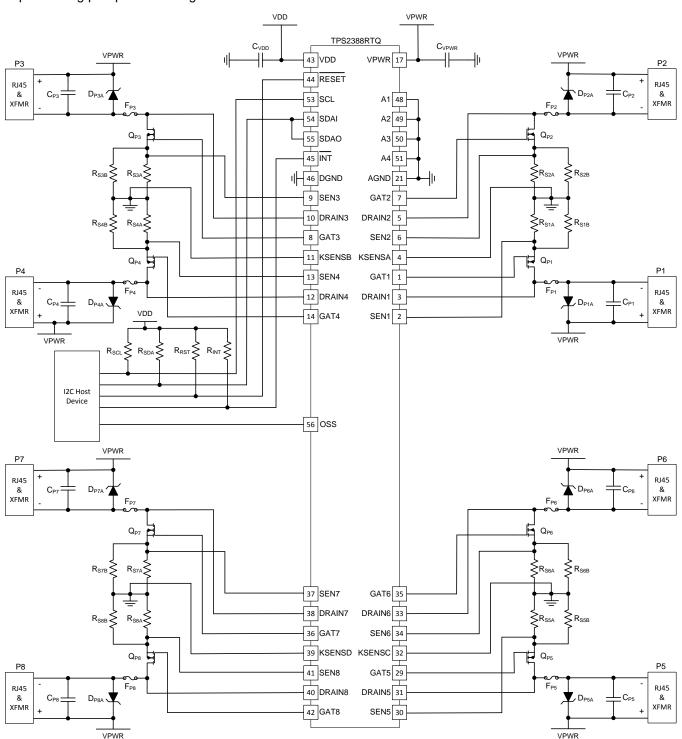


Figure 71. Eight Port Semiauto Mode Application



#### 9.2.1 Design Requirements

The RESET pin may be connected to the micro-controller if an external RESET is required or connected directly to VDD. TPS2388 devices are used in the eight port configuration and are managed by the I<sup>2</sup>C host device. The I<sup>2</sup>C address for TPS2388 is programmed using the A4..A1 pins.

#### 9.2.2 Detailed Design Procedure

## 9.2.2.1 Power Pin Bypass Capacitors

- C<sub>VPWR</sub>: 0.1 μF, 100 V, X7R ceramic at pin 17 (VPWR)
- C<sub>VDD</sub>: 0.1 μF, 50 V, X7R ceramic at pin 43 (VDD)

#### 9.2.2.2 Per Port Components

- C<sub>Pn</sub>: 0.1-μF, 100-V, X7R ceramic between VPWR and Pn-
- R<sub>SnA</sub> / R<sub>SnB</sub>: The port current sense resistors are a combination of two 0.51-Ω, 1% resistors in parallel (0.255 Ω). Dual 0.51-Ω, 1%, 0.25-W resistors in an 0805 SMT package are recommended. If a nominal 640 mA Policing (I<sub>CUT</sub>) threshold is selected, the maximum power dissipation for the resistor pair becomes approximately 115 mW (~57 mW each).
- $Q_{Pn}$ : The port MOSFET can be a small, inexpensive device with average performance characteristics. BV<sub>DSS</sub> should be 100 V minimum. Target a MOSFET R<sub>DS(on)</sub> at V<sub>GS</sub> = 10 V of between 50 m $\Omega$  and 150 m $\Omega$ . The MOSFET GATE charge (Q<sub>G</sub>) and input capacitance (C<sub>ISS</sub>) should be less than 50 nC and 2000 pF respectively. The maximum power dissipation for Q<sub>Pn</sub> with RDS(on) = 100 m $\Omega$  at 640 mA nominal policing (I<sub>CUT</sub>) threshold is approximately 45 mW.
- $F_{Pn}$ : The port fuse should be a slow blow type rated for at least 60 VDC and above ~2 x  $I_{CUT}(max)$ . The cold resistance should be below 200 m $\Omega$  to reduce the DC losses. The power dissipation for FPn with a cold resistance of 180 m $\Omega$  at maximum  $I_{CUT}$  is approximately 81 mW.
- D<sub>PnA</sub>: The port TVS should be rated for the expected port surge environment. D<sub>PnA</sub> should have a minimum reverse standoff voltage of 58 V, peak pulse power rating of 600 W, and a maximum clamping voltage of less than 95 V at the expected peak surge current

## 9.2.2.3 System Level Components (not shown in the schematic diagrams)

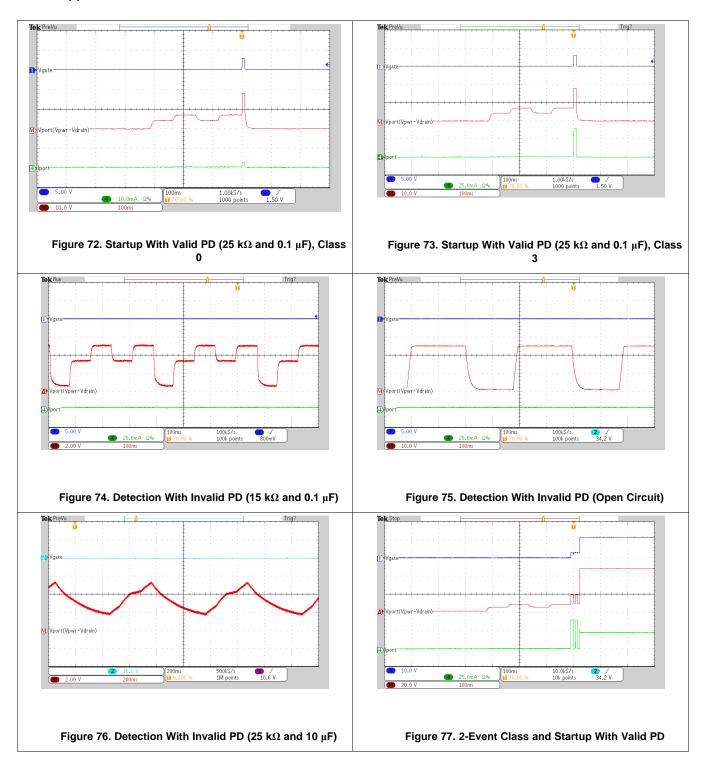
The system TVS and bulk VPWR capacitance work together to protect the PSE system from surge events which could cause VPWR to surge above 70 V. The TVS and bulk capacitors should be placed on the PCB such that all TPS2388 ports are adequately protected.

- TVS: The system TVS should have a minimum reverse standoff voltage of 58 V and a peak pulse power
  rating of 600 W or 1500 W depending on the total number of system ports and amount of bulk VPWR
  capacitance used. Together with the VPWR bulk capacitance, the TVS must prevent the VPWR rail from
  exceeding 70 V.
- **Bulk Capacitor:** The system bulk capacitor(s) should be rated for 100 V and can be of aluminum electrolytic type. Two 47-μF capacitors can be used for each TPS2388 on board.
- **Distributed Capacitance:**In higher port count systems, it may be necessary to distribute 1-uF, 100-V, X7R ceramic capacitors across the 48-V power bus. One capacitor per each TPS2388 pair is recommended.
- **Digital I/O Pullup Resistors:** RESET and A1-A4 are internally pulled up to VDD, while OSS is internally pulled down, each with a 50-k $\Omega$  (typical) resistor. A stronger pull-up/down resistor can be added externally such as a 10 k $\Omega$ , 1%, 0.063 W type in a SMT package. SCL, SDAI, SDAO, and INT require external pull-up resistors within a range of 1 k $\Omega$  to 10 k $\Omega$  depending on the total number of devices on the bus .
- Ethernet Data Transformer (per port): The Ethernet data transformer must be rated to operate within the IEEE802.3at standard in the presence of the DC port current conditions. The transformer is also chosen to be compatible with the Ethernet PHY. The transformer may also be integrated into the RJ45 connector and cable terminations.
- RJ45 Connector (per port): The majority of the RJ45 connector requirements are mechanical in nature and include tab orientation, housing type (shielded or unshielded), or highly integrated. An integrated RJ45 consists of the Ethernet data transformer and cable terminations at a minimum. The integrated type may also contain the port TVS and common mode EMI filtering.

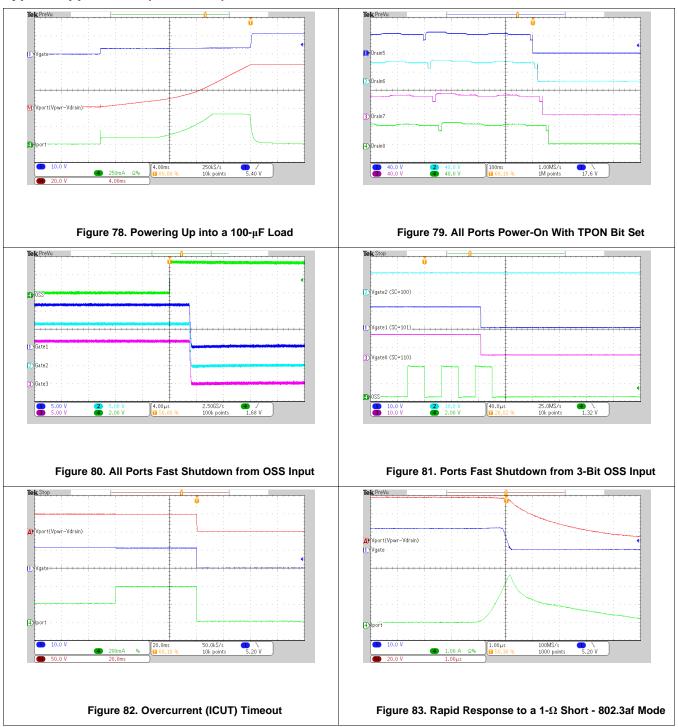


• Cable Terminations (per port): The cable terminations typically consist of series resistor (usually 75 Ω) and capacitor (usually 10 nF) circuits from each data transformer center tap to a common node which is then bypassed to a chassis ground (or system earth ground) with a high-voltage capacitor (usually 1000 pF to 4700 pF at 2 kV).

#### 9.2.3 Application Curves

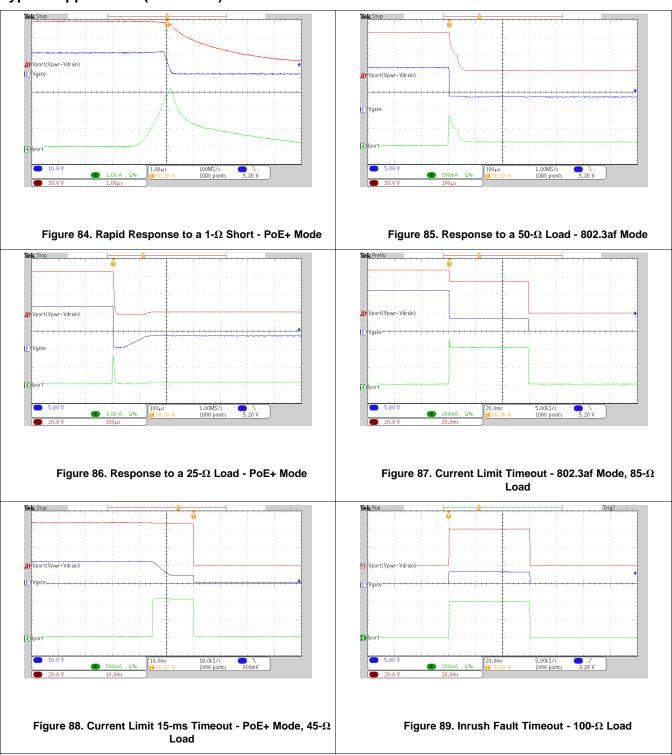




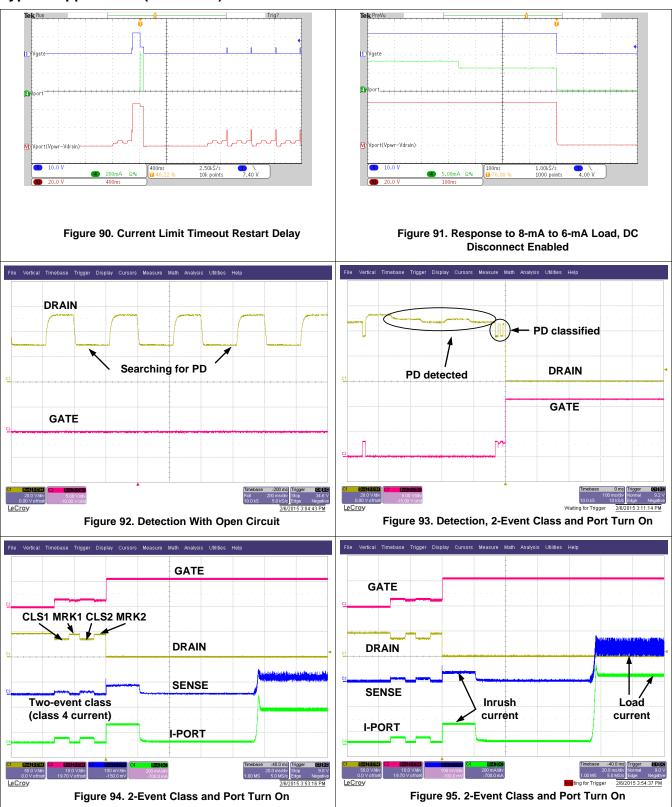


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## **Typical Application (continued)**









## 10 Power Supply Recommendations

#### 10.1 VDD

The recommended VDD supply voltage requirement is 3.3 V,  $\pm 0.3 \text{ V}$ . TPS2388 requires approximately 6 mA typical and 12 mA maximum from the VDD supply. The VDD supply can be generated from VPWR with a bucktype regulator (LM5007 or LM5019 based) for a higher port count PSE using multiple TPS2388 devices operating in semiauto mode. The power supply design must ensure the VDD rail rises monotonically through the VDD UVLO thresholds without any droop under the UVLO\_fall threshold as the loads are turned on. This is accomplished with proper bulk capacitance across the VDD rail for the expected load current steps over worst case design corners. Furthermore, the combination of decoupling capacitance and bulk storage capacitance must hold the VDD rail above the UVLO\_fall threshold during any expected transient outages once power is applied.

#### 10.2 VPWR

The recommended VPWR supply voltage requirement is 44 V to 57 V. A power supply with a nominal 48-V or 54-V output can support both type 1 and type 2 PD requirements. The output current required from the VPWR supply depends on the number and type of ports required in the system. The TPS2388 can be configured for type 1 and type 2 ports and the current limit is set proportionally. I<sub>CUT</sub> is programmable, for example for a type 1 port it can be 380 mA , ±5%, while for a type 2 port it can be 640 mA, ±5%. Size the VPWR supply accordingly for the number and type of ports to be supported. As an example, the VPWR power supply rating should be greater than 3.2 A for eight type 1 ports or greater than 5.5 A for eight type 2 ports, assuming maximum port and standby currents.

## 11 Layout

#### 11.1 Layout Guidelines

#### 11.1.1 Port Current Kelvin Sensing

KSENSA is shared between SEN1 and SEN2, KSENSB is shared between SEN3 and SEN4, KSENSC is shared between SEN5 and SEN6, and KSENSD is shared between SEN7 and SEN8. To optimize the accuracy of the measurement, the PCB layout must be done carefully to minimize impact of PCB trace resistance. Refer to as an example.

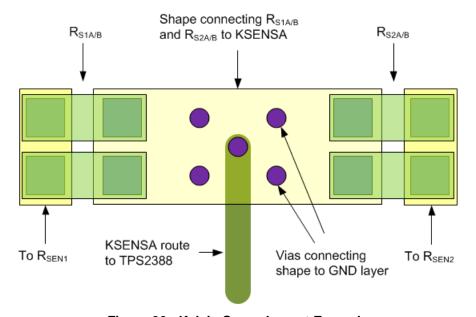


Figure 96. Kelvin Sense Layout Example



## 11.2 Layout Example

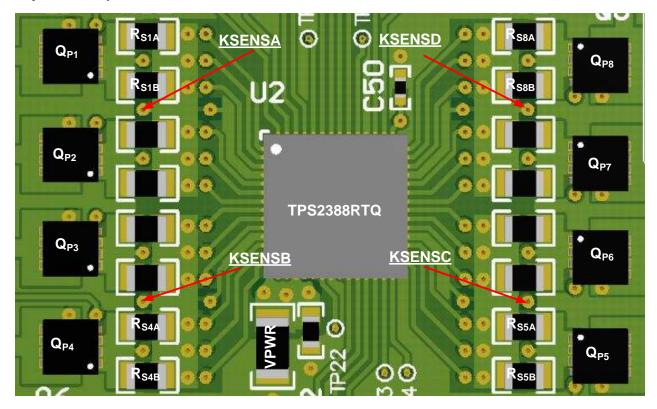


Figure 97. Eight Port Layout Example (Top Side)

#### 11.2.1 Component Placement and Routing Guidelines

#### 11.2.1.1 Power Pin Bypass Capacitors

- C<sub>VPWR</sub>: Place close to pin 17 (VPWR) and connect with low inductance traces and vias according to Figure 97.
- C<sub>VDD</sub>: Place close to pin 43 (VDD) and connect with low inductance traces and vias according to Figure 97

## 11.2.1.2 Per-Port Components

- R<sub>SnA</sub> / R<sub>SnB</sub>: Place according to in a manner that facilitates a clean Kelvin connection with KSENSEA/B/C/D.
- Q<sub>Pn</sub>: Place Q<sub>Pn</sub> around the TPS2388 as illustrated in Figure 97. Provide sufficient copper from Q<sub>Pn</sub> drain to F<sub>Pn</sub>.
- F<sub>Pn</sub>, C<sub>Pn</sub>, D<sub>PnA</sub>, D<sub>PnB</sub>: Place this circuit group near the RJ45 port connector (or port power interface if a daughter board type of interface is used as illustrated in Figure 97). Connect this circuit group to Q<sub>Pn</sub> drain or GND (TPS2388- AGND) using low inductance traces.



# 12 Device and Documentation Support

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#### 12.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

# 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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## PACKAGE OPTION ADDENDUM



10-Dec-2020

#### **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TPS2388RTQR	ACTIVE	QFN	RTQ	56	2000	RoHS & Green	NIPDAU   NIPDAUAG	Level-3-260C-168 HR	-40 to 125	TPS2388RTQ	Samples
TPS2388RTQT	ACTIVE	QFN	RTQ	56	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 125	TPS2388RTQ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# TAPE AND REEL INFORMATION





Α0	
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS2388RTQR	QFN	RTQ	56	2000	330.0	16.4	8.3	8.3	1.1	12.0	16.0	Q2
TPS2388RTQT	QFN	RTQ	56	250	180.0	16.4	8.3	8.3	1.1	12.0	16.0	Q2

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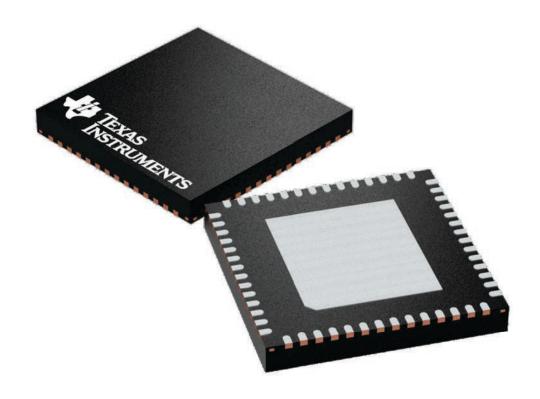


#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS2388RTQR	QFN	RTQ	56	2000	367.0	367.0	38.0
TPS2388RTQT	QFN	RTQ	56	250	210.0	185.0	35.0

8 x 8, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



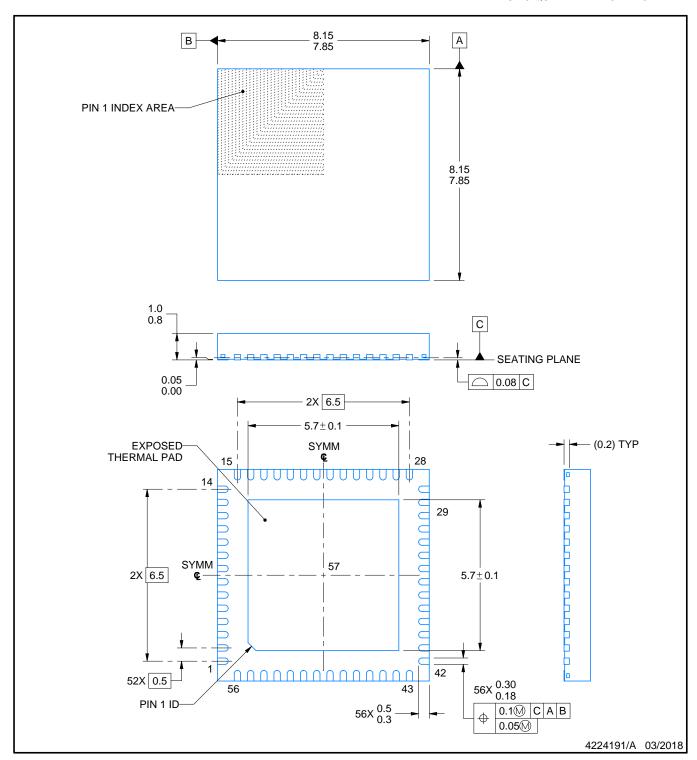
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4224653/A





PLASTIC QUAD FLATPACK - NO LEAD

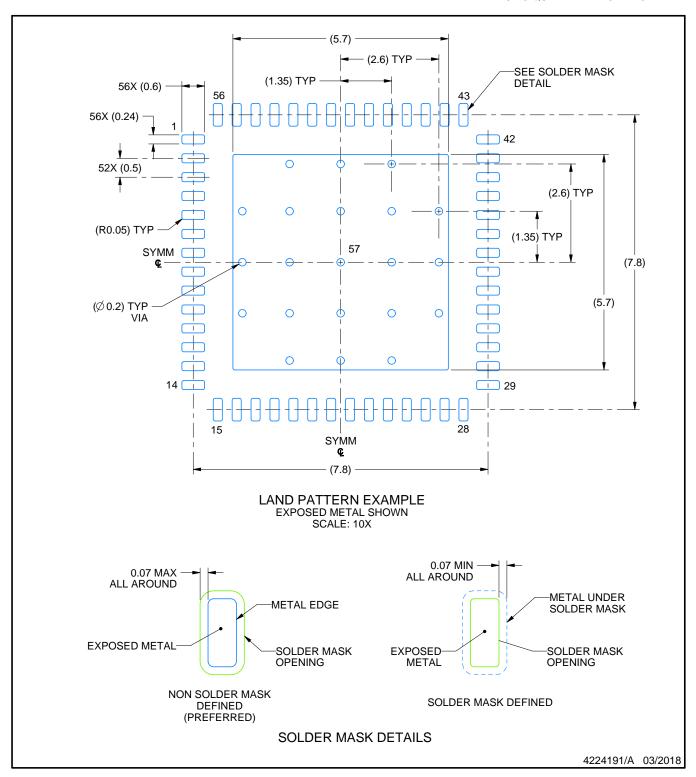


#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC QUAD FLATPACK - NO LEAD

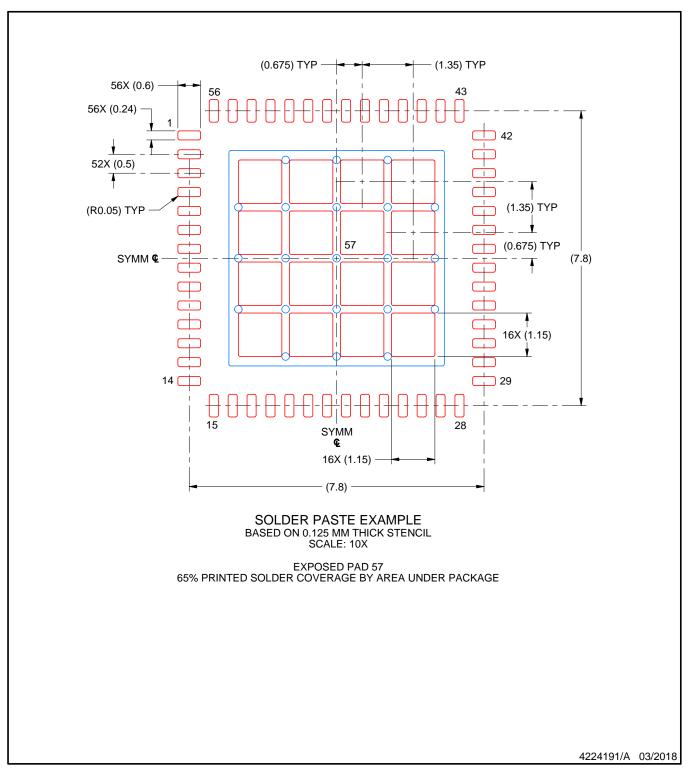


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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